



# Datasheet

## Sona™ IF573

*Version 0.2*

PRELIMINARY

## REVISION HISTORY

Version	Date	Notes	Contributors	Approver
0.1	8 June 2023	Initial version	Various	Andy Ross
0.2	13 July 2023	Updates to <a href="#">Table 37: M.2 2230 E-Key pin definitions</a> – WL_DEV_WAKE and BT_DEV_WAKE voltage	Jacky Kuo	Andrew Chen

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## 1 SCOPE

This document describes key hardware aspects of the Laird Connectivity Sona™ IF573 series wireless modules providing either PCIe v3.0 Gen2 or SDIO 3.0 interface for WLAN connection and high-speed 4-wire UART interface for Bluetooth® connection. This document is intended to assist device manufacturers and related parties with the integration of this radio into their host devices. Data in this document is drawn from several sources and includes information found in the Infineon CYW55573MIWBGT data sheet issued on March 23, 2023, along with other documents provided by Infineon.

**Note:** The information in this document is subject to change. Please contact Laird Connectivity to obtain the most recent version of this document.

## 2 INTRODUCTION

### 2.1 General Description

The Sona IF573 series wireless module is an integrated, small form factor Wi-Fi/Bluetooth module that is optimized for low-power mobile devices, featuring:

- Wi-Fi 6E: Tri-band 2x2 MIMO IEEE 802.11a/b/g/n/ac/ax WLAN
- Bluetooth® 5.4: Dual Mode

The integration of all WLAN and Bluetooth functionality in a single package supports low cost and simple implementation along with flexibility for platform-specific customization. It is available in both M.2 2230 E-Key and M.2 1318 solder-down form factor.

This device is pre-calibrated and integrates the complete transmit/receive RF paths including bandpass filter, diplexer, switches, reference crystal oscillator, and power management units (PMU). Both variants support three integrated MHF4 connectors, with two ports for WLAN and one dedicated for Bluetooth. The M.2 1318 solder down module also supports an RF trace pin option for use with external antenna solutions. For a list of certified antennas see [Certified Antennas](#) in the datasheet.

The Sona IF573 series device supports IEEE 802.11ax tri-band (2.4/5/6 GHz) 2x2 MIMO with data rates up to MCS11 (287 Mbps PHY data rate for 2.4 GHz band and 1.2 Gbps PHY data rate for 5/6 GHz). The device has a dedicated Bluetooth port for best Wi-Fi + Bluetooth coexistence performance. The device's low power consumption, radio architecture and power management unit (PMU) proprietary power save technologies allow for extended battery life.

In addition, its tri-band IEEE 802.11ax and Bluetooth radio includes full digital MAC and baseband engines that handle all 802.11 CCK/OFDM/OFDMA® 2.4/5/6 GHz and Bluetooth 5.4 (Basic Rate, Enhanced Data Rate, and Bluetooth Low Energy) baseband and protocol processing.

The Sona IF573 series wireless modules include two product SKUs which have different RF paths. Please contact Laird Connectivity Sales/FAE for further information. Ordering information is listed in [Table 1](#).

**Table 1: Product ordering information**

Part Number	Description
453-00117R	Sona IF573 1318 Module, MHF4, Tape and Reel
453-00117C	Sona IF573 1318 Module, MHF4, Cut Tape
453-00118R	Sona IF573 1318 Module, RF Trace Pin, Tape and Reel
453-00118C	Sona IF573 1318 Module, RF Trace Pin, Cut Tape
453-00119	Sona IF573 M.2 2230 Module, Key E, SDIO/UART
453-00120	Sona IF573 M.2 2230 Module, Key E, PCIe/UART
453-00119-K1	Sona IF573 M.2 2230 Module Development Kit, SDIO/UART
453-00120-K1	Sona IF573 M.2 2230 Module Development Kit, PCIe/UART

### 3 SONA IF573 SERIES FEATURES SUMMARY

The Laird Connectivity Sona IF573 series device features are described in [Table 2](#).

**Table 2: Sona IF573 series wireless module features**

Feature	Description
<b>Radio Front End</b>	<ul style="list-style-type: none"> <li>▪ Integrates the complete transmit/receive RF paths including bandpass filter, diplexer, switches, reference crystal oscillator, and power manage unit (PMU)</li> <li>▪ Supports tri-band (2.4/5/6 GHz)</li> <li>▪ Supports 20/40/80 MHz channel bandwidth</li> <li>▪ Supports 2x2 WLAN antenna configuration with dedicated Bluetooth antenna port</li> </ul>
<b>Power Management</b>	Two buck regulator, multiple LDO regulators, and a power management unit (PMU) are integrated into the CYW55573MIWBGT. All regulators are programmable via the PMU. These blocks simplify power supply design for Bluetooth and WLAN functions in embedded designs.
<b>Pre-Calibration</b>	RF system tested and calibrated in production
<b>Sleep Clock</b>	An external sleep clock of 32.768 kHz is required.
<b>Host Interface</b>	<p>The Sona IF573 M.2 card provides two interfaces for customers to choose:</p> <ol style="list-style-type: none"> <li>1. <b>SDIO/UART</b>, Wi-Fi section provides support for SDIO v3.0 and also is backward compatible with SDIO v2.0. Bluetooth section supports a high-speed 4-wire UART interface.</li> <li>2. <b>PCIe/UART</b>, Wi-Fi section provides support for PCIe Gen2 (3.0 Compliant). Bluetooth section supports a high-speed 4-wire UART interface.</li> </ol>
<b>Advanced WLAN</b>	<ul style="list-style-type: none"> <li>▪ IEEE 802.11a/b/g/n/ac/ax compliant, tri-band capable (2.4/5/6 GHz)</li> <li>▪ 2x2 MIMO providing up to 1.2 Gbps PHY data rate for 5/6 GHz (1024-QAM modulation)</li> <li>▪ 2x2 MIMO providing up to 287 Mbps PHY data rate for 2.4 GHz (1024-QAM modulation)</li> <li>▪ Supports 20, 40, and 80 MHz channels with optional SGI (1024-QAM modulation)</li> <li>▪ Background channel availability check (CAC) scan for immediate switch to candidate DFS channel</li> <li>▪ On-chip power amplifiers and low-noise amplifiers for both bands</li> <li>▪ Support wide variety of WLAN encryption: WPA/WPA2/WPA3/TKIP/AES and IEEE 802.11i compatibility</li> </ul>
<b>Advanced Bluetooth</b>	<ul style="list-style-type: none"> <li>▪ Bluetooth 5.4 (BDR + EDR + Bluetooth LE)</li> <li>▪ Dedicated Bluetooth RF path port</li> <li>▪ Bluetooth Class 1 or Class 2 transmitter operation</li> <li>▪ Support data rate: 1 Mbps (GFSK), 2 Mbps (<math>\pi/4</math>-DQPSK), 3 Mbps (8-DPSK), LE-1 Mbps, LE-2 Mbps, LE-LR-500K (S=2) and LE-LR-125K (S=8)</li> <li>▪ Supports extended synchronous connections (eSCO) for enhanced voice quality by allowing for retransmission of dropped packets</li> <li>▪ Adaptive frequency hopping (AFH) for reducing radio frequency interference</li> <li>▪ Host controller interface (HCI) using a highspeed UART and PCM/I2S for audio data</li> <li>▪ Low power consumption improves battery life of IoT and embedded devices</li> <li>▪ Supports multiple simultaneous Advanced Audio Distribution Profiles (A2DP) for stereo sound</li> <li>▪ On-chip memory includes 512 KB SRAM and 2 MB ROM</li> </ul>

## 4 SPECIFICATIONS

Table 3: Specifications

Feature	Description	
<b>Physical Interface</b>	M.2 2230 E-Key standard form factor M.2 1318 108-pin LGA package (including 8 thermal ground pads under the package)	
<b>Wi-Fi Interface</b>	PCIe v3.0 Gen2 Secure Digital I/O 2.0/3.0	
<b>Bluetooth/BLE Interface</b>	Host Controller Interface (HCI) using high speed UART	
<b>Main Chipset</b>	Infineon AIROC™ CYW55573MIWBGT	
<b>Input Voltage Requirements</b>	Typical DC 3.3 V, operating range from DC 3.13V to 3.5V	
<b>I/O Signalling Voltage</b>	Compliant with M.2 standard Typical DC 1.8 V ± 5%	
<b>Operating Temperature</b>	-40° to +85°C (-40° to +185°F) Note: Absolute junction temperature 125 °C limit is maintained through active thermal monitoring, throttling, and turning off one of the TX chains or both.	
<b>Operating Humidity</b>	10 to 90% (non-condensing)	
<b>Storage Temperature</b>	-40° to +85°C (-40° to +185°F)	
<b>Storage Humidity</b>	10 to 90% (non-condensing)	
<b>MSL (Moisture Sensitivity Level)</b>	4	
<b>Maximum Electrostatic Discharge</b>	Conductive 8KV; Air coupled 12KV (follows EN61000-4-2)	
<b>Size</b>	M.2 1318 ▪ Length: 18 mm ▪ Width: 13 mm ▪ Thickness: 0.43 mm	M.2 E-Key ▪ Length: 30 mm ▪ Width: 22 mm Thickness: 3.1 mm
<b>Weight – g (oz.)</b>	M.2 1318 ▪ ~0.7	M.2 E-Key ▪ 3
<b>Wi-Fi Media</b>	Direct Sequence-Spread Spectrum (DSSS) Complementary Code Keying (CCK) Orthogonal Frequency Division Multiplexing (OFDM) Orthogonal Frequency Division Multiple Access (OFDMA)	
<b>Bluetooth Media</b>	Frequency Hopping Spread Spectrum (FHSS)	
<b>Wi-Fi Multimedia</b>	WMM Wi-Fi Multimedia - PowerSave (WMM-PS with U-APSD) WMM-Sequential Access (WMM-SA)	
<b>Network Architecture Types</b>	Infrastructure (client operation)	
<b>Wi-Fi Standards</b>	IEEE 802.11ax, 11ac, 11a/b/g/n, 11d/h, 11i, 11r, 11w, 11e, 11k, 11ai, 11v	
<b>Bluetooth Standards</b>	Bluetooth 2.1 + EDR, 3.0, 4.2, 5.0, 5.1, 5.2, 5.3, 5.4	



Feature	Description	
<b>Regulatory Certifications</b>	United States (FCC) EU - Member countries of European Union (ETSI) Great Britain (UKCA) Canada (ISED) Australia (RCM) Japan (MIC)	
<b>2.4 GHz Frequency Bands</b>	<b>EU:</b> 2.4 GHz to 2.483 GHz <b>FCC/ISED:</b> 2.4 GHz to 2.473 GHz <b>UKCA:</b> 2.4 GHz to 2.483 GHz <b>MIC:</b> 2.4 GHz to 2.483 GHz <b>RCM:</b> 2.4 GHz to 2.483 GHz	
<b>2.4 GHz Operating Channels (Wi-Fi)</b>	<b>EU:</b> 13 (3 non-overlapping) <b>FCC/ISED:</b> 11 (3 non-overlapping) <b>UKCA:</b> 13 (3 non-overlapping) <b>MIC:</b> 13 (4 non-overlapping) <b>RCM:</b> 13 (3 non-overlapping)	
<b>5 GHz Frequency Bands</b>	<b>EU</b> 5.15 GHz to 5.35 GHz (Ch 36/40/44/48/52/56/60/64) 5.47 GHz to 5.725 GHz (Ch 100/104/108/112/116/120/124/128/132/136/140) 5.725 GHz to 5.85 GHz (Ch 149/153/157/161/165) <b>FCC</b> 5.15 GHz to 5.35 GHz (Ch 36/40/44/48/52/56/60/64) 5.47 GHz to 5.725 GHz (Ch 100/104/108/112/116/120/124/128/132/136/140/144) 5.725 GHz to 5.85 GHz (Ch 149/153/157/161/165) <b>ISED</b> 5.15 GHz to 5.35 GHz (Ch 36/40/44/48/52/56/60/64) 5.47 GHz to 5.725 GHz (Ch 100/104/108/112/116/132/136/140/144) 5.725 GHz to 5.85 GHz (Ch 149/153/157/161/165) <b>UKCA</b> 5.15 GHz to 5.35 GHz (Ch 36/40/44/48/52/56/60/64) 5.47 GHz to 5.730 GHz (Ch 100/104/108/112/116/120/124/128/132/136/140/144) 5.725 GHz to 5.850 GHz (Ch 149/153/157/161/165) <b>MIC</b> 5.15 GHz to 5.35 GHz (Ch 36/40/44/48/52/56/60/64) 5.47 GHz to 5.725 GHz (Ch 100/104/108/112/116/120/124/128/132/136/140) <b>RCM</b> 5.15 GHz to 5.35 GHz (Ch 36/40/44/48/52/56/60/64) 5.47 GHz to 5.725 GHz (Ch 100/104/108/112/116/132/136/140) 5.725 GHz to 5.85 GHz (Ch 149/153/157/161/165)	
<b>5 GHz Operating Channels (Wi-Fi)</b>	EU: 24 non-overlapping; FCC: 25 non-overlapping ISED: 22 non-overlapping; MIC: 19 non-overlapping RCM: 21 non-overlapping; UKCA: 25 non-overlapping	
<b>6 GHz Frequency Bands</b>	<b>FCC / ISED</b> UNII-5, 5.925 GHz to 6.415 GHz UNII-6, 6.435 GHz to 6.515 GHz UNII-7, 6.535 GHz to 6.875 GHz UNII-8, 6.895 GHz to 7.115 GHz <b>EU</b> UNII-5, 5.945 GHz to 6.425 GHz	<b>UKCA</b> UNII-5, 5.945 GHz to 6.425 GHz <b>MIC</b> UNII-5, 5.945 GHz to 6.425 GHz <b>RCM</b> UNII-5, 5.945 GHz to 6.425 GHz

Feature	Description
<b>6 GHz Operating Channels (Wi-Fi)</b>	FCC/ISED: 59 non-overlapping ETSI/MIC/RCM/UKCA: 24 non-overlapping

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Feature	Description	
<b>Typical Receiver Sensitivity</b> (PER <= 10%)	<b>802.11a:</b>	
	6 Mbps	-92 dBm
	54 Mbps	-75 dBm
<b>Note:</b> All values nominal, +/- 3 dBm.	<b>802.11b:</b>	
	1 Mbps	-96 dBm (PER < 8%)
	11 Mbps	-90 dBm (PER < 8%)
	<b>802.11g:</b>	
	6 Mbps	-93 dBm
	54 Mbps	-76 dBm
	<b>802.11n (2.4 GHz)</b>	
	6.5 Mbps (MCS0; HT20)	-93 dBm
	65 Mbps (MCS7; HT20)	-75 dBm
	<b>802.11ax (2.4 GHz)</b>	
	7.3 Mbps (MCS0; HE20)	-93 dBm
	121.9 Mbps (MCS11; HE20)	-62 dBm
	7.3 Mbps (MCS0; HE20/RU242)	-93 dBm
	<b>802.11n (5 GHz)</b>	
	6.5 Mbps (MCS0; HT20)	-93 dBm
	65 Mbps (MCS7; HT20)	-73 dBm
	13.5Mbps (MCS0; HT40)	-90 dBm
	135Mbps (MCS7; HT40)	-71 dBm
	<b>802.11ac (5 GHz)</b>	
	6.5 Mbps (MCS0; VHT20)	-93 dBm
	78 Mbps (MCS8; VHT20)	-70 dBm
	13.5 Mbps (MCS0; VHT40)	-90 dBm
	180 Mbps (MCS9; VHT40)	-65 dBm
	29.3 Mbps (MCS0; VHT80)	-87 dBm
	390 Mbps (MCS9; VHT80)	-62 dBm
	<b>802.11ax (5 GHz)</b>	
	7.3 Mbps (MCS0; HE20)	-90 dBm
	121.9 Mbps (MCS11; HE20)	-60 dBm
	7.3 Mbps (MCS0; HE20/RU242)	-90 dBm
	14.6 Mbps (MCS0; HE40)	-88 dBm
	243.8 Mbps (MCS11; HE40)	-58 dBm
	14.6 Mbps (MCS0; HE40/RU484)	-88 dBm
	30.6 Mbps (MCS0; HE80)	-87dBm
	510.4 Mbps (MCS11; HE80)	-55 dBm
	30.6 Mbps (MCS0; HE80/RU996)	-87 dBm
	<b>802.11ax (6 GHz, UNII-5)</b>	
	6 Mbps	-90 dBm
	24 Mbps	-83 dBm
	7.3 Mbps (MCS0; HE20)	-90 dBm
	121.9 Mbps (MCS11; HE20)	-60 dBm
	7.3 Mbps (MCS0; HE20/RU242)	-90 dBm
	14.6 Mbps (MCS0; HE40)	-89 dBm
	243.8 Mbps (MCS11; HE40)	-56 dBm
	14.6 Mbps (MCS0; HE40/RU484)	-89 dBm
	30.6 Mbps (MCS0; HE80)	-87 dBm
	510.4 Mbps (MCS11; HE80)	-54 dBm
	30.6 Mbps (MCS0; HE80/RU996)	-87 dBm

Feature	Description
<b>802.11ax (6 GHz, UNII-6)</b>	
6 Mbps	-89 dBm
24 Mbps	-82 dBm
7.3 Mbps (MCS0; HE20)	-89 dBm
121.9 Mbps (MCS11; HE20)	-59 dBm
7.3 Mbps (MCS0; HE20/RU242)	-89 dBm
14.6 Mbps (MCS0; HE40)	-88 dBm
243.8 Mbps (MCS11; HE40)	-55 dBm
14.6 Mbps (MCS0; HE40/RU484)	-88 dBm
30.6 Mbps (MCS0; HE80)	-85 dBm
510.4 Mbps (MCS11; HE80)	-54 dBm
30.6 Mbps (MCS0; HE80/RU996)	-85 dBm
<b>802.11ax (6GHz, UNII-7)</b>	
6 Mbps	-86 dBm
24 Mbps	-81 dBm
7.3 Mbps (MCS0; HE20)	-86 dBm
121.9 Mbps (MCS11; HE20)	-58 dBm
7.3 Mbps (MCS0; HE20/RU242)	-86 dBm
14.6 Mbps (MCS0; HE40)	-85 dBm
243.8 Mbps (MCS11; HE40)	-55 dBm
14.6 Mbps (MCS0; HE40/RU484)	-85 dBm
30.6 Mbps (MCS0; HE80)	-84 dBm
510.4 Mbps (MCS11; HE80)	-52 dBm
30.6 Mbps (MCS0; HE80/RU996)	-84 dBm
<b>802.11ax (6 GHz, UNII-8)</b>	
6 Mbps	-85 dBm
24 Mbps	-79 dBm
7.3 Mbps (MCS0; HE20)	-85 dBm
121.9 Mbps (MCS11; HE20)	-56 dBm
7.3 Mbps (MCS0; HE20/RU242)	-85 dBm
14.6 Mbps (MCS0; HE40)	-84 dBm
243.8 Mbps (MCS11; HE40)	-53 dBm
14.6 Mbps (MCS0; HE40/RU484)	-84 dBm
30.6 Mbps (MCS0; HE80)	-83 dBm
510.4 Mbps (MCS11; HE80)	-51 dBm
30.6 Mbps (MCS0; HE80/RU996)	-83 dBm
<b>Bluetooth:</b>	
1 Mbps (1DH5)	-91 dBm
2Mbps (2DH5)	-93 dBm
3 Mbps (3DH5)	-87 dBm
LE-1 Mbps	-95 dBm
LE-2 Mbps	-92 dBm
LE-LR (S=2)	-102 dBm
LE-LR (S=8)	-107 dBm
<b>Operating Systems Supported</b>	Linux Android
<b>Security</b>	<ul style="list-style-type: none"> <li>▪ WPA, WPA2 (Enterprise) and WPA3 (Enterprise) support for powerful encryption and authentication</li> <li>▪ AES and TKIP in hardware for faster data encryption and IEEE 802.11i compatibility</li> <li>▪ Reference WLAN subsystem provides Wi-Fi Protected Setup (WPS)</li> </ul>

Feature	Description	
<b>Compliance</b>		
	<b>EU</b>	
	EN 300 328	EN 62368-1:2014
	EN 301 489-1	EN 300 440
	EN 301 489-17	EN 303 687
	EN 301 893	2011/65/EU (RoHS)
	<b>FCC</b>	<b>ISED Canada</b>
	47 CFR FCC Part 15.247	RSS-247
	47 CFR FCC Part 15.407	RSS-248
	47 CFR FCC Part 2.1091	
	<b>AS/NZS</b>	<b>MIC</b>
	AS/NZS 4268:2017	ARIB STD-T66/RCR STD-33 (2.4 GHz) ARIB STD-T71 (5 GHz) Article 2 Paragraph 1 of Item 80 : LPI (ZR), 6 GHz
<b>Certifications</b>	<b>Bluetooth® SIG Qualification</b>	
	D063147	
<b>Warranty</b>	One Year Warranty	
<i>All specifications are subject to change without notice</i>		

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## 5 WLAN FUNCTIONAL DESCRIPTION

### 5.1 Overview

The Sona IF573 series wireless module is designed based on the Infineon AIROC CYW55573MIWBGT Wi-Fi 6E chipset (dual-core 2x2 MIMO). It is optimized for high speed, reliability, and low-power embedded applications. It is integrated with tri-band WLAN (2.4/5/6 GHz) and Bluetooth 5.4. Its functionality is listed in [Table 4](#).

**Table 4: WLAN functions**

Feature	Description
<b>WLAN MAC</b>	<ul style="list-style-type: none"> <li>▪ Enhanced MAC for supporting IEEE 802.11a/b/g/n/ac/ax features</li> <li>▪ Transmission and reception of HE-SU and HE-ER-SU PPDU</li> <li>▪ Reception of HE-MU PPD -OFDMA/MU-MIMO frame</li> <li>▪ Transmission of HE-TB PPDU (Uplink MU OFDMA)</li> <li>▪ Transmission and reception of A-MPDUs/AMSDUs for very high throughput (VHT)</li> <li>▪ Support for power management schemes, including WMM power-save, programmable state machine (PSM) operation</li> <li>▪ Support for all ACK and Block-ACK policies as per standard</li> <li>▪ Interframe space timing support, including RIFS</li> <li>▪ Support for RTS/CTS and CTS-to-nowhere frame sequences for protecting frame exchanges</li> <li>▪ Timing synchronization function (TSF), network allocation vector (NAV) maintenance, and target beacon transmission time (TBTT) generation in hardware and capturing the TSF timer on an external time synchronization pulse</li> <li>▪ Hardware offload for cipher suites/encryption types WEP, TKIP(WPA), AES(WPA2), support for WPA3-SAE and key management</li> <li>▪ Support for coexistence with Bluetooth</li> <li>▪ RTS-CTS based BW signaling mechanism support</li> </ul>
<b>WLAN Security</b>	<ul style="list-style-type: none"> <li>▪ WLAN Encryption features supported include: <ul style="list-style-type: none"> <li>– Temporal Key Integrity Protocol (TKIP)/Wired Equivalent Privacy (WEP)</li> <li>– Advanced Encryption Standard (AES)/Wi-Fi Multi-Media (WMM)</li> <li>– WLAN Authentication and Private Infrastructure (WPAI)</li> </ul> </li> </ul>





## 6 BLUETOOTH FUNCTIONAL DESCRIPTION

The Sona IF573 series wireless module includes a fully integrated Bluetooth baseband/radio. Several features and functions are listed in [Table 5](#).

**Table 5: Bluetooth functions**

Feature	Description
<b>Bluetooth Interface</b>	<ul style="list-style-type: none"> <li>▪ Voice interface:           <ul style="list-style-type: none"> <li>– Supported by PCM transports and bi-directional operations.</li> <li>– Sample rates 8k for NBS and 16k for WBS supported.</li> <li>– Sample width is limited to 16-bits.</li> <li>– Synchronization clock width of 1 or 3 (short or long)</li> <li>– Bit clocks of 128k, 256k, 512k, 1024k and 2048k, the only difference being the number of 16bit slots.</li> <li>– HFP samples can be taken from any available slot. Slot 0 is the default slot.</li> </ul> </li> <li>▪ High-Speed UART interface</li> </ul>
<b>Bluetooth Core functionality</b>	<ul style="list-style-type: none"> <li>▪ Supports all Bluetooth 5.3 and 4.2 features</li> <li>▪ Dual-mode Bluetooth low energy</li> <li>▪ Bluetooth LE LE-2Mbps mode, LE-Long Range mode, Advertising Extensions, Slot Availability Masks</li> <li>▪ Extended inquiry response (EIR): Shortens the time to retrieve the device name, specific profile, and operating mode</li> <li>▪ Encryption pause resume (EPR): Enables the us of Bluetooth technology in a much more secure environment</li> <li>▪ Sniff subrating (SSR): Optimizes power consumption for low duty cycle asymmetric data flow, which subsequently extends battery life.</li> <li>▪ Secure simple pairing (SSP): Reduces the number of steps for connecting two devices, with minimal or no user interaction required.</li> <li>▪ Link supervision time out (LSTO): Additional commands added to HCI and link management protocol (LMP) for improved link time-out supervision.</li> <li>▪ QoS enhancements: Changes to data traffic control, which results in better link performance. Audio, human interface device (HID), bulk traffic. SCO, and enhanced SCO (eSCO) are improved with the erroneous data (ED) and packet boundary flag (PBF) enhancements.</li> </ul>
<b>Bluetooth Features</b>	<ul style="list-style-type: none"> <li>▪ Supports features of Bluetooth Core Specification version 5.2:           <ul style="list-style-type: none"> <li>– LE Isochronous Channels</li> <li>– LE Power Control</li> </ul> </li> <li>▪ Supports features of Bluetooth Core Specification version 5.1:           <ul style="list-style-type: none"> <li>– Direction Finding (AoA/AoD)</li> <li>– Additional Advertising Channels</li> <li>– Periodic Advertising Sync Transfer (PAST)</li> <li>– GATT Caching</li> </ul> </li> <li>▪ Supports features of Bluetooth Core Specification version 5.0:           <ul style="list-style-type: none"> <li>– LE 2Mbps</li> <li>– LE Long Range (LE-LR)</li> <li>– Stable Modulation Index for LE</li> <li>– LE Advertising Extension</li> <li>– Slot Availability Masks (SAM)</li> <li>– Channel Selection Algorithm</li> <li>– High Duty Cycle Non-Connectable Advertising</li> </ul> </li> <li>▪ Supports features of Bluetooth Core Specification version 4.0 + EDR           <ul style="list-style-type: none"> <li>– Adaptive frequency hopping (AFH)</li> <li>– Quality of service (QoS)</li> <li>– Extended synchronous connections (eSCO) – Voice Connections</li> <li>– Fast connect (interlaced page and inquiry scans)</li> <li>– Secure simple pairing (SSP)</li> </ul> </li> </ul>

Feature	Description
	<ul style="list-style-type: none"><li>- Sniff subrating (SSR)</li><li>- Encryption pause resume (EPR)</li><li>- Extended inquiry response (EIR)</li><li>- Link supervision timeout (LST)</li><li>▪ Multipoint operation with up to seven active slaves<ul style="list-style-type: none"><li>- Maximum of seven simultaneous active ACL links</li><li>- Maximum of three simultaneous active SCO and eSCO connections with scattement support</li></ul></li><li>▪ High-speed HCI UART transport support with low-power out-of-band BT_DEV_WAKE and BT_HOST_WAKE signaling.</li></ul>

PRELIMINARY

## 7 BLOCK DIAGRAMS

### 7.1 M.2 1318 Solder-down

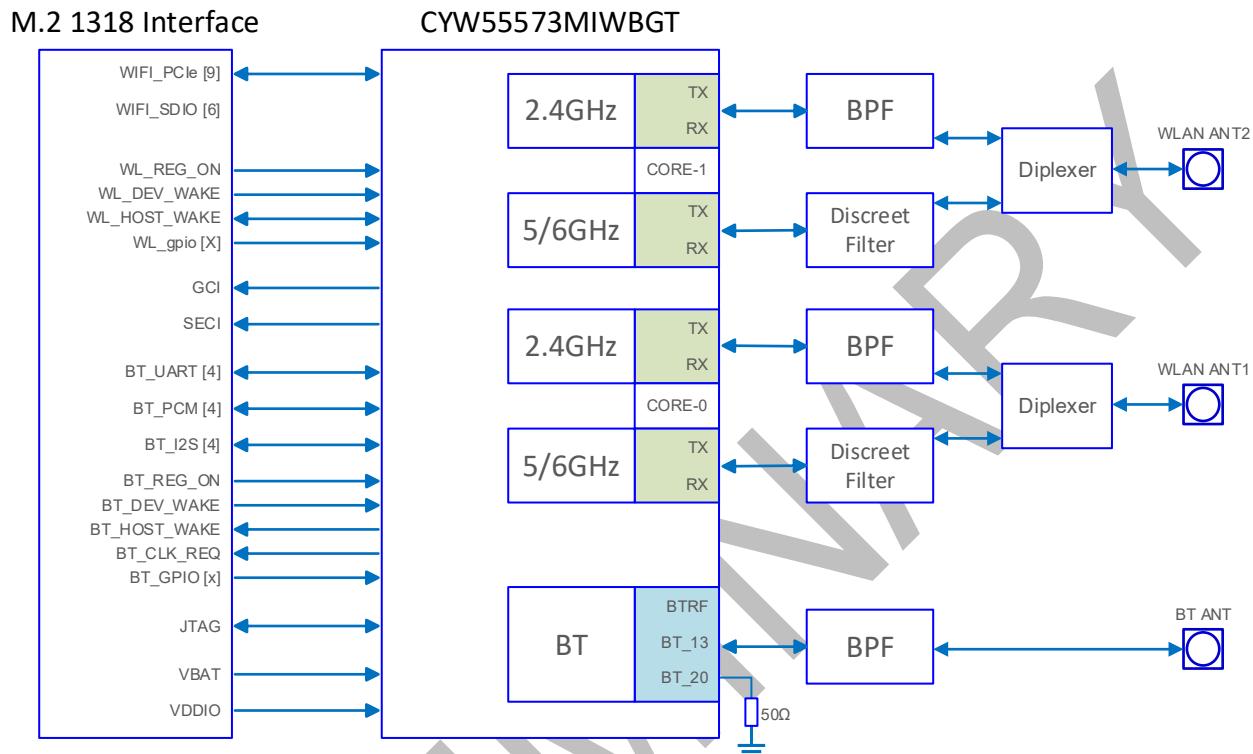


Figure 1: M.2 1318

## 7.2 M.2 2230 E-Key

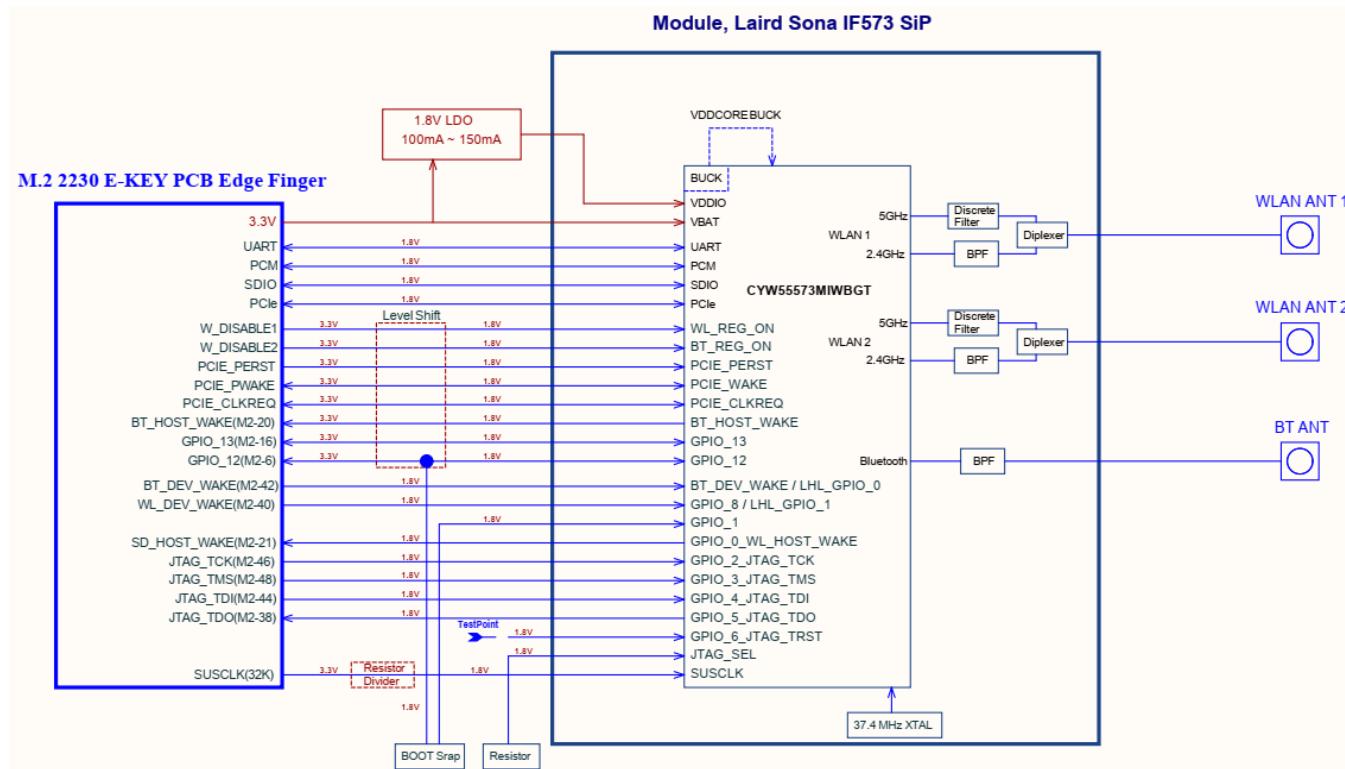


Figure 2: M.2 2230 E-Key

## 8 ELECTRICAL CHARACTERISTICS

### 8.1 Absolute Maximum Ratings

Table 6 summarizes the absolute maximum ratings and Table 7 lists the recommended operating conditions for the Sona IF573 series wireless module. Absolute maximum ratings are those values beyond which damage to the device can occur. Functional operation under these conditions, or at any other condition beyond those indicated in the operational sections of this document, is not recommended.

**Note:** Maximum rating for signals follows the supply domain of the signals.

Table 6: Absolute maximum ratings

Symbol (Domain)	Description	Max Rating	Unit
VBAT	External DC power supply (M.2 1318)	+6.0	V
VDDIO	DC supply voltage for digital I/O (M.2 1318)	2.2	V
3V3	External 3.3V power supply (M.2 2230 E-Key)	4.0	V
Storage	Storage temperature	-40 to +125	°C
Antenna	Maximum RF input (reference to 50-Ω input)	+10	dBm
ESD	Electrostatic discharge tolerance	2000	V

## 8.2 Recommended Operating Conditions

**Table 7: Recommended operating conditions**

Symbol (Domain)	Parameter	Min	Typ	Max	Unit
VBAT	External DC power supply	3.13	3.3	3.47	V
VDDIO	DC supply voltage for digital I/O	1.71	1.8	1.89	V
T-ambient	Ambient temperature	-40	25	+85	°C

## 8.3 DC Electrical Characteristics

Table 8 list the general DC electrical characteristics over recommended operating conditions (unless otherwise specified).

**Table 8: General DC electrical characteristics (For 1.8V operation VDDIO)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
VIH	High Level Input Voltage	—	0.65 x VDDIO	—	—	V
VIL	Low Level Input Voltage	—	—	—	0.35 x VDDIO	V
VOH	Output high Voltage	—	VDDIO - 0.4	—	—	V
VOL	Output low Voltage	—	—	—	0.45	V

## 8.4 WLAN Radio Receiver Characteristics

Table 9, Table 10, and Table 11 summarize the Sona IF573 series wireless module receiver characteristics.

**Table 9: WLAN receiver characteristics for 2.4 GHz single chain operation**

Item	Parameter	Conditions	Min	Typ	Max	Unit
Frequency Range	Receive input frequency range	—	2.412	—	2.484	GHz
Modulation Type	Sensitivity					
	CCK, 1 Mbps	See Note <sup>1</sup>	—	-96	—	dBm
	CCK, 11 Mbps		—	-90	—	
	OFDM, 6 Mbps		—	-93	—	
	OFDM, 54 Mbps		—	-76	—	
	HT20, MCS0		—	-93	—	
	HT20, MCS7		—	-75	—	
	HE20, MCS0		—	-93	—	
	HE20, MCS11		—	-62	—	
ACI - OFDM	Adjacent channel rejection					
[Difference between interfering and desired signal (25 MHz apart)]	OFDM, 6 Mbps	See Note <sup>1</sup>	—	30	—	dB
	OFDM, 54 Mbps		—	15	—	
ACI – 11n MCS0-7	HT20, MCS0		—	30	—	
[Difference between interfering and desired signal (25 MHz apart)]	HT20, MCS7		—	10	—	
ACI – 11ax MCS0-11	HE20, MCS0		—	30	—	
[Difference between interfering and desired signal (25 MHz apart)]	HE20, MCS7		—	10	—	
	HE20, MCS11		—	TBD	—	

**Table 10: WLAN receiver characteristics for 5 GHz single chain operation**

Item	Parameter	Conditions	Min	Typ	Max	Unit
Frequency Range	Receive input frequency range	—	5.15	—	5.825	GHz
Modulation Type	Sensitivity					
	OFDM, 6 Mbps	See Note <sup>1</sup>	—	-92	—	dBm
	OFDM, 54 Mbps		—	-75	—	
	HT20, MCS0		—	-93	—	
	HT20, MCS7		—	-73	—	
	HT40, MCS0		—	-90	—	
	HT40, MCS7		—	-71	—	
	VHT20, MCS0		—	-93	—	
	VHT20, MCS8		—	-70	—	
	VHT40, MCS0		—	-90	—	
	VHT40, MCS9		—	-65	—	
	VHT80, MCS0		—	-87	—	
	VHT80, MCS9		—	-62	—	
	HE20, MCS0		—	-92	—	
	HE20, MCS11		—	-60	—	
	HE40, MCS0		—	-90	—	
	HE40, MCS11		—	-58	—	
	HE80, MCS0		—	-87	—	
	HE80, MCS11		—	-55	—	
ACI - OFDM	Adjacent channel rejection					
[Difference between interfering and desired signal (20 MHz apart)]	OFDM, 6 Mbps	—	25	—	—	dB
	OFDM, 54 Mbps	See Note <sup>1</sup>	—	5	—	
ACI – MCS0-11	MCS0	—	25	—	—	dB
[Difference between interfering and desired signal (20 MHz apart)]	MCS7	See Note <sup>1</sup>	—	5	—	
	MCS11		—	TBD	—	
ACI – MCS0-11	MCS0	—	24	—	—	dB
[Difference between interfering and desired signal (40 MHz apart)]	MCS7	See Note <sup>1</sup>	—	5	—	
	MCS11		—	TBD	—	
ACI – MCS0-11	MCS0	—	TBD	—	—	dB
[Difference between interfering and desired signal (80 MHz apart)]	MCS7	See Note <sup>1</sup>	—	TBD	—	
	MCS11		—	TBD	—	

Table 11: WLAN receiver characteristics for 6 GHz single chain operation

Item	Parameter	Conditions	Typical (Sensitivity)				Unit
			UNII-5	UNII-6	UNII-7	UNII-8	
Frequency Range	Receive input frequency range	—	5950 - 6415	6435 - 6515	6535 - 6875	6895 - 7115	MHz
Modulation Type	OFDM, 6Mbps	See Note <sup>1</sup>	-92	-91	-90	-88	dBm
	OFDM, 24Mbps		-83	-82	-81	-79	
	HE20, MCS0		-92	-91	-90	-89	
	HE20, MCS7		-74	-73	-72	-70	
	HE20, MCS8		-69	-68	-67	-66	
	HE20, MCS9		-68	-67	-66	-64	
	HE20, MCS11		-60	-59	-58	-56	
	HE40, MCS0		-90	-89	-88	-86	
	HE40, MCS7		-71	-70	-69	-67	
	HE40, MCS8		-67	-66	-65	-63	
	HE40, MCS9		-65	-64	-63	-61	
	HE40, MCS11		-56	-55	-55	-53	
	HE80, MCS0		-87	-85	-84	-83	
	HE80, MCS7		-68	-67	-65	-64	
	HE80, MCS8		-64	-63	-62	-60	
	HE80, MCS9		-62	-61	-60	-58	
	HE80, MCS11		-54	-54	-52	-51	
ACI - OFDM [Difference between interfering and desired signal (20 MHz apart)]	6 Mbps	See Note <sup>1</sup>	25	25	25	25	dB
ACI – MCS0-11 [Difference between interfering and desired signal (20 MHz apart)]	MCS0	See Note <sup>1</sup>	25	25	25	25	
	MCS7		5	5	5	5	
	MCS9		TBD	TBD	TBD	TBD	
	MCS11		TBD	TBD	TBD	TBD	
ACI – MCS0-11 [Difference between interfering and desired signal (40 MHz apart)]	MCS0	See Note <sup>1</sup>	24	24	24	24	
	MCS7		5	5	5	5	
	MCS9		TBD	TBD	TBD	TBD	
	MCS11		TBD	TBD	TBD	TBD	

Note 1: Performance data are measured in single chain operation.

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## 8.7 WLAN Transmitter Characteristics

Table 12 through Table 21 summarize the Sona IF573 series wireless module transmitter characteristics.

**Table 12: WLAN transmitter characteristics for 2.4 GHz operation (VBAT = 3.3V, VDDIO = 1.8V)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Ftx	Transmit output frequency range	—	2.402	—	2.484	GHz
Pout	Output power	See Note <sup>2</sup>	—	—	—	—
	11b mask compliant	1-11Mbps	—	18	—	dBm
	11g mask compliant	6-24Mbps	—	18	—	
	11g mask compliant	36-48Mbps	—	17	—	
	11g EVM compliant	54Mbps	—	16	—	
	11n HT20 mask compliant	MCS0-4	—	16	—	
	11n HT20 mask compliant	MCS5-6	—	15	—	
	11n HT20 EVM compliant	MCS7	—	14	—	
	11ax HE20 mask compliant	MCS0-4	—	16	—	
	11ax HE20 mask compliant	MCS5-6	—	15	—	
	11ax HE20 EVM compliant	MCS7	—	14	—	
	11ax HE20 EVM compliant	MCS8	—	12.5	—	
	11ax HE20 EVM compliant	MCS9	—	11.5	—	
	11ax HE20 EVM compliant	MCS10-11	—	10.5	—	
ATx	Transmit power accuracy at 25 °C	—	-2.0	—	+2.0	dB

**Table 13: WLAN current consumption on 2.4 GHz (VBAT = 3.3V, VDDIO = 1.8V, BT\_REG\_ON = Low)**

Modulation	Data Rate	Spatial Stream	Output Power (dBm)	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
CCK	1 Mbps	1	19.5	392	6.71
BPSK	6 Mbps	1	19.5	378	6.71
64-QAM	HT20 MCS7	1	15.5	305	6.4
64-QAM	HT20 MCS15	2	15.5	470	9.82
256-QAM	HE20 MCS9	2	13	415	9.76
1024-QAM	HE20 MCS11	2	102	398	9.68

**Table 14: WLAN transmitter characteristics for 5 GHz operation (VBAT=3.3V, VDDIO=1.8V)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Ftx	Transmit output frequency range	—	5.15	—	5.925	GHz
Pout	Output power	See Note <sup>2</sup>	—	—	—	—
	11a mask compliant	6-48Mbps	—	17	—	dBm
	11a EVM compliant	54Mbps	—	16	—	
	11n HT20 mask compliant	MCS0-5	—	17	—	
	11n HT20 EVM compliant	MCS6-7	—	16	—	
	11n HT40 mask compliant	MCS0-5	—	16	—	
	11n HT40 EVM compliant	MCS6-7	—	15	—	
	11ac VHT20 mask compliant	MCS0-5	—	17	—	
	11ac VHT20 EVM compliant	MCS6-7	—	16	—	
	11ac VHT20 EVM compliant	MCS8	—	14	—	
	11ac VHT40 mask compliant	MCS0-5	—	16	—	
	11ac VHT40 EVM compliant	MCS6-7	—	15	—	
	11ac VHT40 EVM compliant	MCS8-9	—	12	—	
	11ac VHT80 mask compliant	MCS0-5	—	16	—	
	11ac VHT80 EVM compliant	MCS6-7	—	15	—	
	11ac VHT80 EVM compliant	MCS8-9	—	12	—	
	11ax HE20 mask compliant	MCS0-5	—	17	—	
	11ax HE20 EVM compliant	MCS6-7	—	16	—	
	11ax HE20 EVM compliant	MCS8-9	—	14	—	
	11ax HE20 EVM compliant	MCS10-11	—	13	—	
	11ax HE40 mask compliant	MCS0-5	—	16	—	
	11ax HE40 EVM compliant	MCS6-7	—	15	—	
	11ax HE40 EVM compliant	MCS8-9	—	12	—	
	11ax HE40 EVM compliant	MCS10-11	—	11.5	—	
	11ax HE80 mask compliant	MCS0-5	—	16	—	
	11ax HE80 EVM compliant	MCS6-7	—	15	—	
	11ax HE80 EVM compliant	MCS8-9	—	12	—	
	11ax HE80 EVM compliant	MCS10-11	—	11	—	
ATx	Transmit power accuracy at 25 °C	—	-2.0	—	+2.0	dB

Table 15: WLAN current consumption on 5 GHz (VBAT = 3.3V, VDDIO = 1.8V, BT\_REG\_ON = Low)

Modulation	Bandwidth (MHz)	Data Rate	Spatial Stream	Output Power (dBm)	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
BPSK	20	6 Mbps	1	18.5	496	6.81
64-QAM	20	54 Mbps	1	17.5	457	6.51
BPSK	20	MCS0	2	18.5	830	11.27
64-QAM	20	MCS7	2	17.5	740	10.47
256-QAM	20	MCS9	2	15.5	685	10.35
1024-QAM	20	MCS11	2	14.5	645	10.26
BPSK	40	MCS0	2	17.5	825	11.12
64-QAM	40	MCS7	2	16.5	741	10.31
256-QAM	40	MCS9	2	13.5	665	10.21
1024-QAM	40	MCS11	2	13	655	10.22
BPSK	80	MCS0	2	17.5	865	10.99
64-QAM	80	MCS7	2	16.5	740	10.27
256-QAM	80	MCS9	2	13.5	705	10.17
1024-QAM	80	MCS11	2	12.5	680	10.17

Table 16: WLAN transmitter characteristics for UNII-5 and UNII-6 operation (VBAT = 3.3V, VDDIO = 1.8V)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Ftx	Transmit output frequency range	—	5.925	—	6.53	GHz
Pout	Output power	See Note <sup>2</sup>	—	—	—	—
	11a mask compliant	6-24Mbps	—	15.5	—	dBm
	11ax HE20 mask compliant	MCS0-6	—	15.5	—	
	11ax HE20 EVM compliant	MCS7	—	15	—	
	11ax HE20 EVM compliant	MCS8	—	14.5	—	
	11ax HE20 EVM compliant	MCS9-11	—	12	—	
	11ax HE40 mask compliant	MCS0-6	—	15.5	—	
	11ax HE40 EVM compliant	MCS7	—	14	—	
	11ax HE40 EVM compliant	MCS8	—	12.5	—	
	11ax HE40 EVM compliant	MCS9	—	12	—	
	11ax HE40 EVM compliant	MCS10-11	—	11	—	
	11ax HE80 mask compliant	MCS0-6	—	15	—	
	11ax HE80 EVM compliant	MCS7	—	14	—	
	11ax HE80 EVM compliant	MCS8	—	12	—	
	11ax HE80 EVM compliant	MCS9	—	11	—	
	11ax HE80 EVM compliant	MCS10-11	—	10	—	
ATx	Transmit power accuracy at 25 °C	—	-2.0	—	+2.0	dB

**Table 17: WLAN current consumption on UNII-5 band (VBAT = 3.3V, VDDIO = 1.8V, BT\_REG\_ON = Low)**

Modulation	Bandwidth (MHz)	Data Rate	Spatial Stream	Output Power (dBm)	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
BPSK	20	6 Mbps	1	17	436	6.71
64-QAM	20	24 Mbps	1	17	430	6.58
BPSK	20	MCS0	2	17	815	11.28
64-QAM	20	MCS7	2	16.5	745	10.46
256-QAM	20	MCS9	2	13.5	644	10.37
1024-QAM	20	MCS11	2	13.5	640	10.26
BPSK	40	MCS0	2	17	831	11.06
64-QAM	40	MCS7	2	15.5	714	10.25
256-QAM	40	MCS9	2	13.5	650	10.19
1024-QAM	40	MCS11	2	12.5	626	10.19
BPSK	80	MCS0	2	16.5	840	10.89
64-QAM	80	MCS7	2	15.5	750	10.21
256-QAM	80	MCS9	2	12.5	662	10.14
1024-QAM	80	MCS11	2	11.5	640	10.15

**Table 18: WLAN current consumption on UNII-6 band (VBAT = 3.3V, VDDIO = 1.8V, BT\_REG\_ON = Low)**

Modulation	Bandwidth (MHz)	Data Rate	Spatial Stream	Output Power (dBm)	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
BPSK	20	6 Mbps	1	17	426	6.71
64-QAM	20	24 Mbps	1	17	417	6.59
BPSK	20	MCS0	2	17	775	11.29
64-QAM	20	MCS7	2	16.5	705	10.48
256-QAM	20	MCS9	2	13.5	610	10.4
1024-QAM	20	MCS11	2	13.5	606	10.28
BPSK	40	MCS0	2	17	785	11.1
64-QAM	40	MCS7	2	15.5	677	10.31
256-QAM	40	MCS9	2	13.5	617	10.21
1024-QAM	40	MCS11	2	12.5	599	10.2
BPSK	80	MCS0	2	16.5	802	10.92
64-QAM	80	MCS7	2	15.5	717	10.24
256-QAM	80	MCS9	2	12.5	635	10.18
1024-QAM	80	MCS11	2	11.5	620	10.16

**Table 19: WLAN transmitter characteristics for UNII-7 and UNII-8 operation (VBAT = 3.3V, VDDIO = 1.8V)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Ftx	Transmit output frequency range	—	6.53	—	7.125	GHz
Pout	Output power	See Note <sup>2</sup>	—	—	—	—
	11a mask compliant	6-24Mbps	—	15	—	dBm
	11ax HE20 mask compliant	MCS0-6	—	15	—	—
	11ax HE20 EVM compliant	MCS7	—	13	—	—
	11ax HE20 EVM compliant	MCS8	—	12	—	—
	11ax HE20 EVM compliant	MCS9-11	—	10.5	—	—
	11ax HE40 mask compliant	MCS0-6	—	15	—	—
	11ax HE40 EVM compliant	MCS7	—	12	—	—
	11ax HE40 EVM compliant	MCS8	—	11	—	—
	11ax HE40 EVM compliant	MCS9	—	10	—	—
	11ax HE40 EVM compliant	MCS10-11	—	8.5	—	—
	11ax HE80 mask compliant	MCS0-6	—	14.5	—	—
	11ax HE80 EVM compliant	MCS7	—	11	—	—
	11ax HE80 EVM compliant	MCS8	—	10	—	—
	11ax HE80 EVM compliant	MCS9-11	—	8.5	—	—
ATx	Transmit power accuracy at 25 °C	—	-2.0	—	+2.0	dB

**Table 20: WLAN current consumption on UNII-7 band (VBAT = 3.3V, VDDIO = 1.8V, BT\_REG\_ON = Low)**

Modulation	Bandwidth (MHz)	Data Rate	Spatial Stream	Output Power (dBm)	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
BPSK	20	6 Mbps	1	16.5	401	6.72
64-QAM	20	24 Mbps	1	16.5	395	6.6
BPSK	20	MCS0	2	16.5	732	11.33
64-QAM	20	MCS7	2	14.5	648	10.53
256-QAM	20	MCS9	2	12	580	10.45
1024-QAM	20	MCS11	2	12	575	10.33
BPSK	40	MCS0	2	16.5	745	11.13
64-QAM	40	MCS7	2	13.5	610	10.35
256-QAM	40	MCS9	2	11.5	575	10.29
1024-QAM	40	MCS11	2	10	555	10.28
BPSK	80	MCS0	2	16	761	10.95
64-QAM	80	MCS7	2	12.5	632	10.27
256-QAM	80	MCS9	2	10	597	10.22
1024-QAM	80	MCS11	2	10	597	10.19

Table 21: WLAN current consumption on UNII-8 band (VBAT = 3.3V, VDDIO = 1.8V, BT\_REG\_ON = Low)

Modulation	Bandwidth (MHz)	Data Rate	Spatial Stream	Output Power (dBm)	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
BPSK	20	6 Mbps	1	16.5	406	6.72
64-QAM	20	24 Mbps	1	16.5	398	6.6
BPSK	20	MCS0	2	16.5	761	11.33
64-QAM	20	MCS7	2	14.5	682	10.55
256-QAM	20	MCS9	2	12	610	10.46
1024-QAM	20	MCS11	2	12	601	10.35
BPSK	40	MCS0	2	16.5	800	11.15
64-QAM	40	MCS7	2	13.5	640	10.37
256-QAM	40	MCS9	2	11.5	599	10.29
1024-QAM	40	MCS11	2	10	582	10.29
BPSK	80	MCS0	2	16	808	10.96
64-QAM	80	MCS7	2	12.5	663	10.28
256-QAM	80	MCS9	2	10	625	10.19
1024-QAM	80	MCS11	2	10	626	10.21

Note2: Final TX power values on each channel may be further limited by regulatory requirements.

## 9 BLUETOOTH RADIO CHARACTERISTICS

Table 22 through Table 26 describe the performance of the Bluetooth transmitter and receiver and the current consumption at 25°C.

**Table 22: BR / EDR transmitter performance (VBAT = 3.3V, VDDIO = 1.8V)**

Test Parameter		Min	Typ	Max	BT Spec.	Unit
Maximum RF Output Power	GFSK	—	—	7	0 ~ +20	dBm
	π/4-DQPSK	—	3	—		
	8-DPSK	—	3	—		
Frequency Range		2.4	—	2.4835	2.4 ≤ f ≤ 2.4835	GHz
20 dB Bandwidth		—	914.5	—	≤ 1000	KHz
Δf1avg Maximum Modulation		140	154	175	140 < Δf1avg < 175	KHz
Δf2max Minimum Modulation		115	147	—	≥ 115	KHz
Δf2avg/Δf1avg		—	0.95	—	≥ 0.80	—
Initial Carrier Frequency		—	± 25	± 75	≤ ± 75	KHz
Frequency Drift (DH1 packet)		—	± 8	± 25	± 25	KHz
Frequency Drift (DH3 packet)		—	± 8	± 40	± 40	KHz
Frequency Drift (DH5 packet)		—	± 8	± 40	± 40	KHz
Drift rate		—	5	20	20	KHz/50us
EDR ωi		—	—	± 75	≤ ± 75	KHz
EDR ω0		—	—	± 10	≤ ± 10	KHz
EDR (ωi + ω0)		—	—	± 75	≤ ± 75	KHz
RMS DEVM for π/4-DQPSK		—	—	≤ 0.2	≤ 0.2	—
RMS DEVM for 8-DPSK		—	—	≤ 0.13	≤ 0.13	—
Peak DEVM for π/4-DQPSK		—	—	≤ 0.35	≤ 0.35	—
Peak DEVM for 8-DPSK		—	—	≤ 0.25	≤ 0.25	—
99% DEVM for π/4-DQPSK		—	—	≤ 0.30	≤ 0.30	—
99% DEVM for 8-DPSK		—	—	≤ 0.20	≤ 0.20	—
EDR In-Band Spurious Emission	M-N  ≥ 2.5 MHz	—	-43	-40	< -40	dBm
	1.5 MHz <  M-N  < 2.5 MHz	—	-31	-20	≤ -20	dBm
	1.0 MHz <  M-N  < 1.5 MHz	—	-38	-26	≤ -26	dBm

**Table 23: Basic Rate receiver performance (VBAT = 3.3V, VDDIO = 1.8V)**

Test Parameter		Min	Typ	Max	Bluetooth Spec.	Unit
Sensitivity (1DH5)	BER ≤ 0.1%	—	-91	—	≤ -70	dBm
Maximum Input	BER ≤ 0.1%	—	—	-20	≥ -20	dBm
Interference Performance	Co-Channel	—	8.5	11	11	dB
	C/I 1 MHz adjacent channel	—	-1.4	0	0	dB
	C/I 2 MHz adjacent channel	—	-41	-30	-30	dB
	C/I ≥ 3 MHz adjacent channel	—	-42.5	-40	-40	dB
	C/I image channel	—	-31.5	-9	-9	dB
	C/I 1-MHz adjacent to image channel	—	-44.5	-20	-20	dB

**Table 24: Enhanced Data Rate receiver performance (VBAT = 3.3V, VDDIO = 1.8V)**

Test Parameter		Min	Typ	Max	Bluetooth Spec.	Unit
Sensitivity (BER ≤ 0.01%)	π/4-DQPSK	—	-93	—	≤ -70	dBm
	8-DPSK	—	-87	—	≤ -70	dBm
Maximum Input (BER ≤ 0.1%)	π/4-DQPSK	—	—	-20	≥ -20	dBm
	8-DPSK	—	—	-20	≥ -20	dBm
C/I Co-Channel (BER ≤ 0.1%)	π/4-DQPSK	—	10.5	13	≤ ±13	dB
	8-DPSK	—	18	21	≤ ±21	dB
C/I 1 MHz adjacent Channel	π/4-DQPSK	—	-6.5	0	≤ 0	dB
	8-DPSK	—	-1	5	≤ 5	dB
C/I 2 MHz adjacent Channel	π/4-DQPSK	—	-38.5	-30	≤ -30	dB
	8-DPSK	—	-36.5	-25	≤ -25	dB
C/I ≥ 3 MHz adjacent Channel	π/4-DQPSK	—	-42.5	-40	≤ -40	dB
	8-DPSK	—	-41.5	-33	≤ -33	dB
C/I image channel	π/4-DQPSK	—	-30	-7	≤ -7	dB
	8-DPSK	—	-22.5	0	≤ 0	dB
C/I 1 MHz adjacent to image channel	π/4-DQPSK	—	-47.5	-20	≤ -20	dB
	8-DPSK	—	-41.5	-13	≤ -13	dB
Out-of-Band Blocking Performance (CW) BER ≤ 0.1%	30-2000MHz	—	-10	—	—	dBm
	2-2.399GHz	—	-27	—	—	dBm
	2.484-3GHz	—	-27	—	—	dBm
	3-12.75GHz	—	-10	—	—	dBm

**Table 25: BLE RF Specifications (VBAT = 3.3V, VDDIO = 1.8V)**

Parameter	Conditions	Min	Typ	Max	Unit
Frequency range	—	2402	—	2480	MHz
Rx sensitivity <sup>1</sup>	GFSK, PER ≤ 30.8%	1 Mbps	—	-95	dBm
		2 Mbps	—	-92	dBm
		500 Kbps	—	-102	dBm
		125 Kbps	—	-107	dBm
Tx power <sup>2</sup>	—	—	—	7	dBm
Δf1 average	1 Mbps	225	255	275.5	KHz
	2 Mbps	450	500	550	KHz
	125 Kbps	225	255	275	KHz
Δf2 average	1 Mbps	185	230	—	KHz
Δf2 maximum <sup>3</sup>	2 Mbps	370	450	—	KHz
Δf1 average (Stable Modulation)	1 Mbps	247.5	250	252.5	KHz
	2 Mbps	495	500	550	KHz
	125 Kbps	247.5	250	252.5	KHz
$\frac{\Delta f_2 \text{ avg}}{\Delta f_1 \text{ avg}}$ ratio	1 Mbps	0.8	1.0	—	%
	2 Mbps	0.8	1.0	—	%

**Table 26: Bluetooth transmitter current consumption (VBAT = 3.3V, VDDIO = 1.8V, WL\_REG\_ON = OFF)**

Operation Mode	Data Rate	VBAT Current Consumption (mA)	VIO Current Consumption (mA)
Basic Data Rate	1DH5	18.9	0.76
Enhanced Data Rate	2DH5	18.4	0.77
	3DH5	18.3	0.77
Low-Energy	1 Mbps	20.3	0.76
	2 Mbps	13.4	0.71
	500 Kbps	17.9	0.75
	125 Kbps	23.6	0.78

**Notes:**

[1] Dirty Tx is Off.

[2] The Bluetooth LE TX power cannot exceed 10 dBm EIRP specification limit. The front-end losses and antenna gain/loss must be factored in so as not to exceed the limit.

[3] At least 99.9% of all Δf2 maximum frequency values recorded over 10 packets must be greater than 185 KHz.

## 10 HOST INTERFACE SPECIFICATIONS

### 10.1 SDIO Specifications

The Sona IF573 series wireless module SDIO host interface pins are powered from the VDDIO voltage supply, which is set internally at 1.8V on the M.2 module. The SDIO electrical specifications are identical for the 1-bit SDIO and 4-bit SDIO modes.

**Note:** The SDIO host signals must be 1.8V at all times as defined by the M.2 standard.

#### 10.1.1 Default Speed, High-Speed Modes

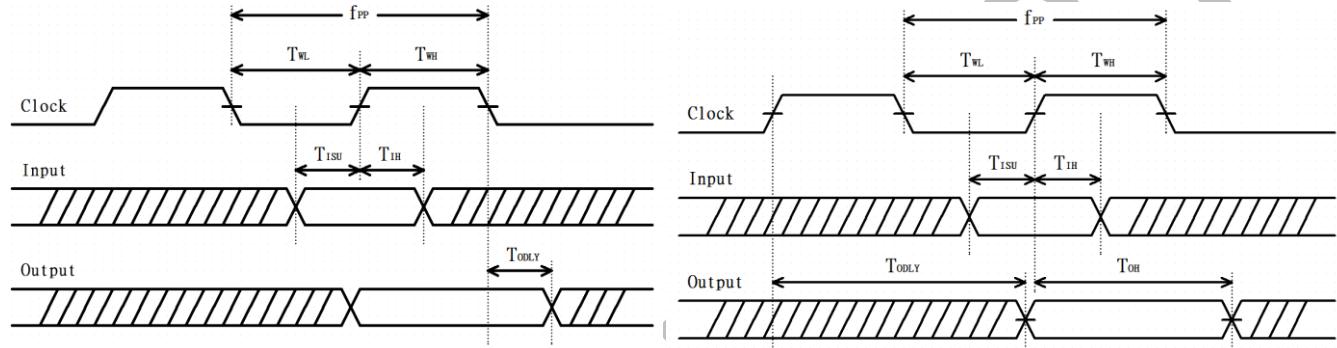


Figure 3: SDIO protocol timing diagram - Default mode (1.8V)

Figure 4: SDIO protocol timing diagram – High-Speed mode (1.8V)

**Note:** Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

Table 27: SDIO timing requirements

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
fPP	Clock Frequency	Default Speed	0	-	25	MHz
		High-Speed	0	-	50	
TWL	Clock low time	Default Speed	10	-	-	ns
		High-Speed	7	-	-	
TWH	Clock high time	Default Speed	10	-	-	ns
		High-Speed	7	-	-	
TISU	Input Setup time	Default Speed	5	-	-	ns
		High-Speed	6	-	-	
TIH	Input Hold time	Default Speed	5	-	-	ns
		High-Speed	2	-	-	
TODLY	Output delay time CL≤40pF (1 card)	Default Speed	-	-	14	ns
		High-Speed	-	-	14	
TOH	Output hold time	High-Speed	0	-	-	ns

## 10.1.2 SDR12, SDR25, SDR50 Modes (up to 100 MHz) (1.8V)

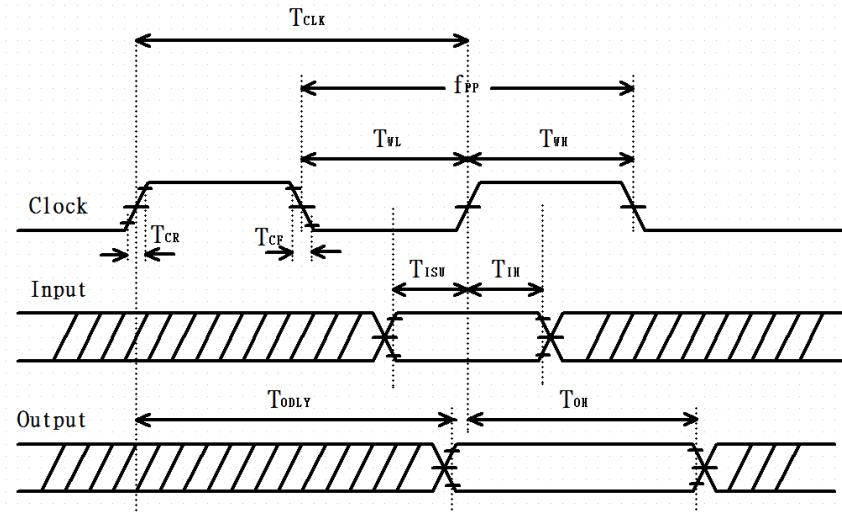


Figure 5: SDIO protocol timing Diagram – SDR12, SDR25, SDR50 modes (up to 100 MHz) (1.8V)

**Note:** Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

Table 28: SDIO timing requirements - SDR12, SDR25, SDR50 modes (up to 100 MHz) (1.8V)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
fPP	Clock Frequency	SDR12/25/50	25	-	100	MHz
TISU	Input setup time	SDR12/25/50	3	--	-	ns
TIH	Input Hold time	SDR12/25/50	0.8	-	-	ns
TCLK	Clock Time	SDR12/25/50	10	-	40	ns
TCR, TCF	Raise time, Fall time TCR, TCF <2ns (max) at 100MHz CCARD=10pF	SDR12/25/50	-	-	0.2*TCLK	ns
TODLY	Output delay time CL≤30pF	SDR12/25/50	-	-	7.5	ns
TOH	Output hold time CL=15pF	SDR12/25/50	1.5	-	-	ns

### 10.1.3 SDR104 Mode (208 MHz) (1.8V)

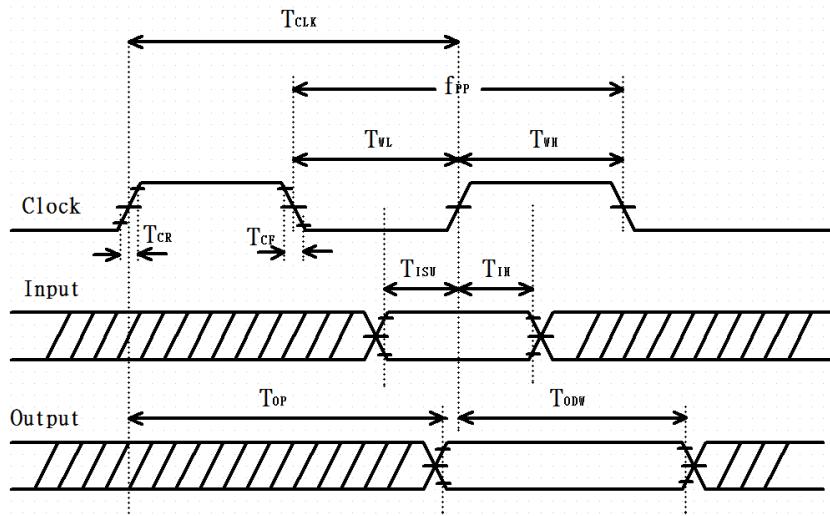


Figure 6: SDIO protocol timing Diagram - SDR104 mode (up to 208 MHz) (1.8V)

**Note:** Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

Table 29: SDIO timing requirements - SDR104 mode (up to 208MHz) (1.8V)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
fPP	Clock Frequency	SDR104	0	-	208	MHz
TISU	Input setup time	SDR104	1.4	--	-	ns
TIH	Input Hold time	SDR104	0.8	-	-	ns
TCLK	Clock Time	SDR104	4.8	-	-	ns
TCR, TCF	Raise time, Fall time TCR, TCF <0.96ns (max) at 208MHz CCARD=10pF	SDR104	-	-	0.2*TCLK	ns
TOP	Card Output phase	SDR104	0	-	10	ns
TODW	Output timing pf variable data window	SDR12/25/50	2.88	-	-	ns

## 10.2 PCI Express Interface

The Sona IF573 series wireless module supports the PCIe interface, which provides high-performance serial I/O interconnects and is also protocol compliant and electrically compatible with the PCI Express Base Specification v3.0 running at Gen2 speeds.

Organization of the PCIe core is in logical layers: Transaction Layer, Data Link Layer, and Physical Layer, as shown in Figure 1<sup>Figure 7</sup>. A configuration or link management block is provided for enumerating the PCIe configuration space and supporting generation and reception of System Management Messages by communicating with PCIe layers.

Each layer is partitioned into dedicated transmit and receive units that allow point-to-point communication between the host and Sona IF573 device. The transmit side processes outbound packets whereas the receive side processes inbound packets. Packets are formed and generated in the Transaction and Data Link Layer for transmission onto the high-speed links and onto the receiving device. A header is added at the beginning to indicate the packet type and any other optional fields.

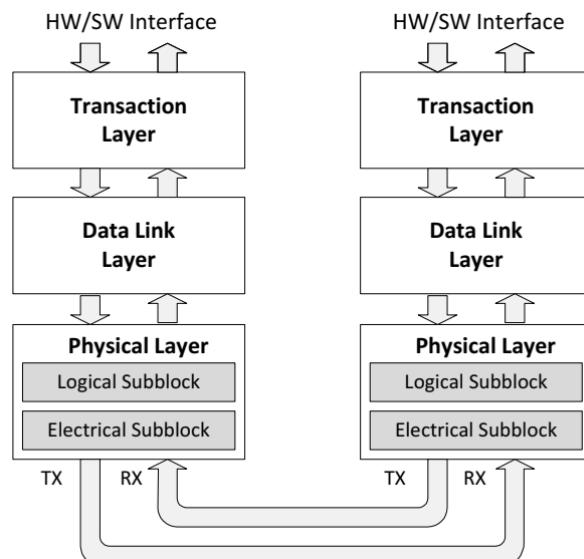


Figure 7: PCI Express Layer Model

## 10.3 PCM Interface Specifications

### 10.3.1 PCM Interface

The Sona IF573 series wireless module supports a PCM interface. The PCM interface on the Sona IF573 series wireless module can connect to linear PCM codec devices in Master/Slave mode. In Master mode, the Sona IF573 generates the BT\_PCM\_CLK and BT\_PCM\_SYNC signals, and in Slave mode, these signals are provided by another master on the PCM interface and are input to the Sona IF573 module.

The configuration of the PCM interface may be adjusted by the host through the use of vendor-specific HCI commands.

### 10.3.2 PCM Interface Timing

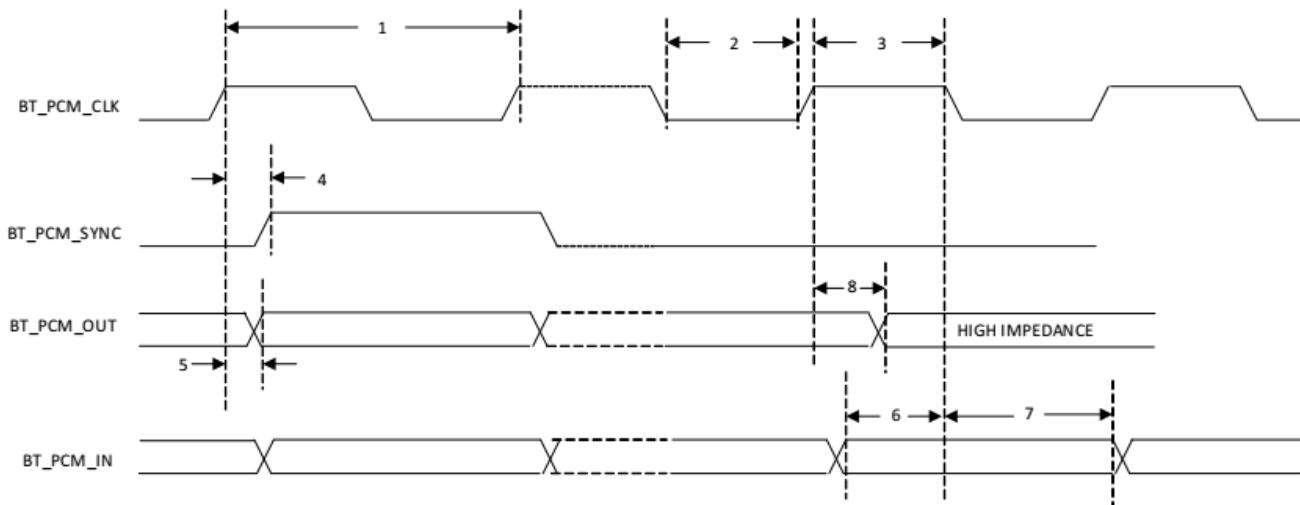


Figure 8: PCM timing specification – Short Frames Sync, Master Mode

Table 30: PCM timing specification – Short Frames Sync, Master Mode

Reference	Characteristics	Min.	Typ.	Max.	Unit
1	PCM bit clock frequency	-	-	12.0	MHz
2	PCM bit clock LOW	41.0	-	-	ns
3	PCM bit clock HIGH	41.0	-	-	ns
4	BT_PCM_SYNC delay	0	-	25.0	ns
5	BT_PCM_OUT delay	0	-	25.0	ns
6	BT_PCM_IN setup	8.0	-	-	ns
7	BT_PCM_IN hold	8.0	-	-	ns
8	Delay from rising edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance	0	-	25.0	ns

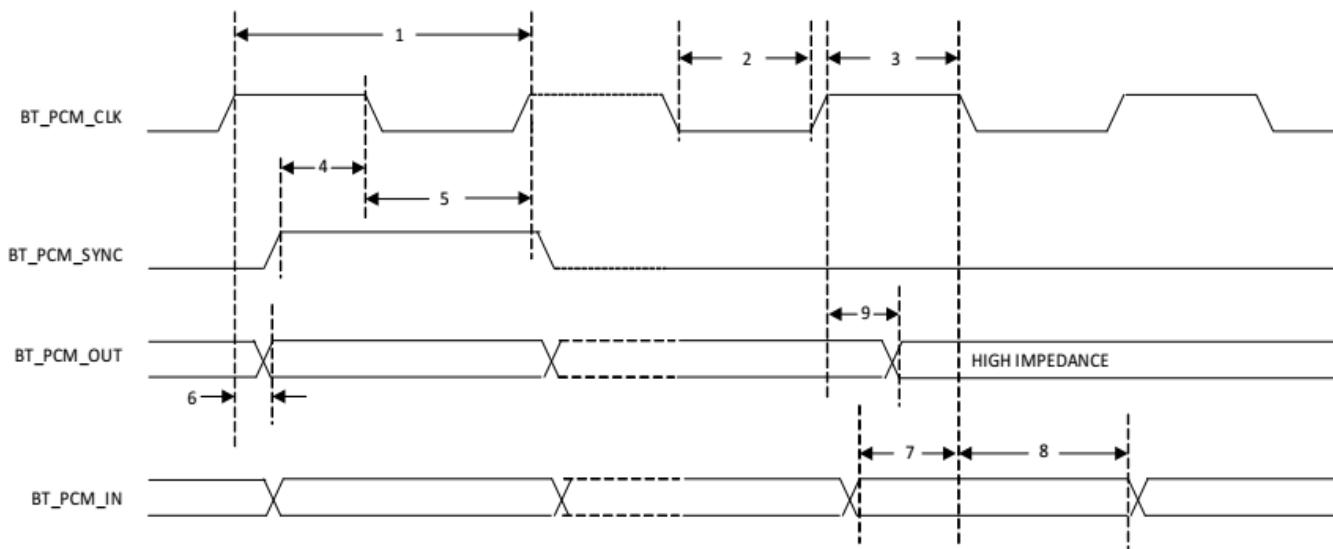


Figure 9: PCM timing specification – Short Frame Sync, Slave Mode

Table 31: PCM timing specification – Short Frame Sync, Slave Mode

Reference	Characteristics	Min.	Typ.	Max.	Unit
1	PCM bit clock frequency	-	-	12.0	MHz
2	PCM bit clock LOW	41.0	-	-	ns
3	PCM bit clock HIGH	41.0	-	-	ns
4	BT_PCM_SYNC setup	8.0	-	-	ns
5	BT_PCM_SYNC hold	8.0	-	-	ns
6	BT_PCM_OUT delay	0	-	25.0	ns
7	BT_PCM_IN setup	8.0	-	-	ns
8	BT_PCM_IN hold	8.0	-	-	ns
9	Delay from rising edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance	0	-	25.0	ns

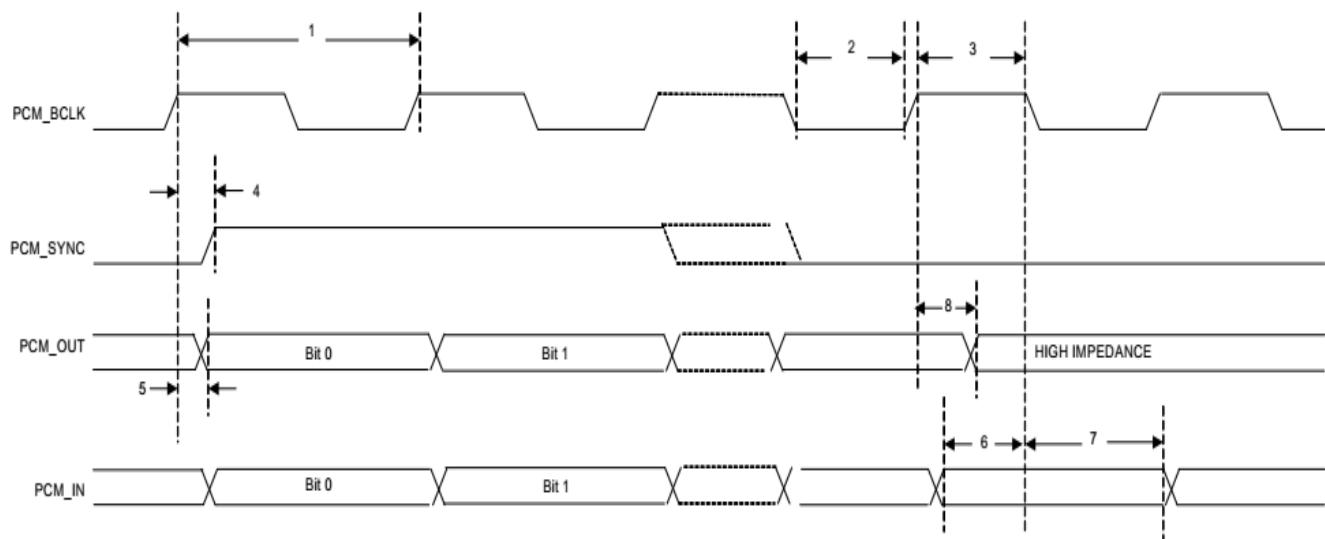


Figure 10: PCM timing specification – Long Frame Sync, Master Mode

Table 32: PCM timing specification – Long Frame Sync, Master Mode

Reference	Characteristics	Min.	Typ.	Max.	Unit
1	PCM bit clock frequency	-	-	12.0	MHz
2	PCM bit clock LOW	41.0	-	-	ns
3	PCM bit clock HIGH	41.0	-	-	ns
4	BT_PCM_SYNC delay	0	-	25.0	ns
5	BT_PCM_OUT delay	0	-	25.0	ns
6	BT_PCM_IN setup	8.0	-	-	ns
7	BT_PCM_IN hold	8.0	-	-	ns
8	Delay from rising edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance	0	-	25.0	ns

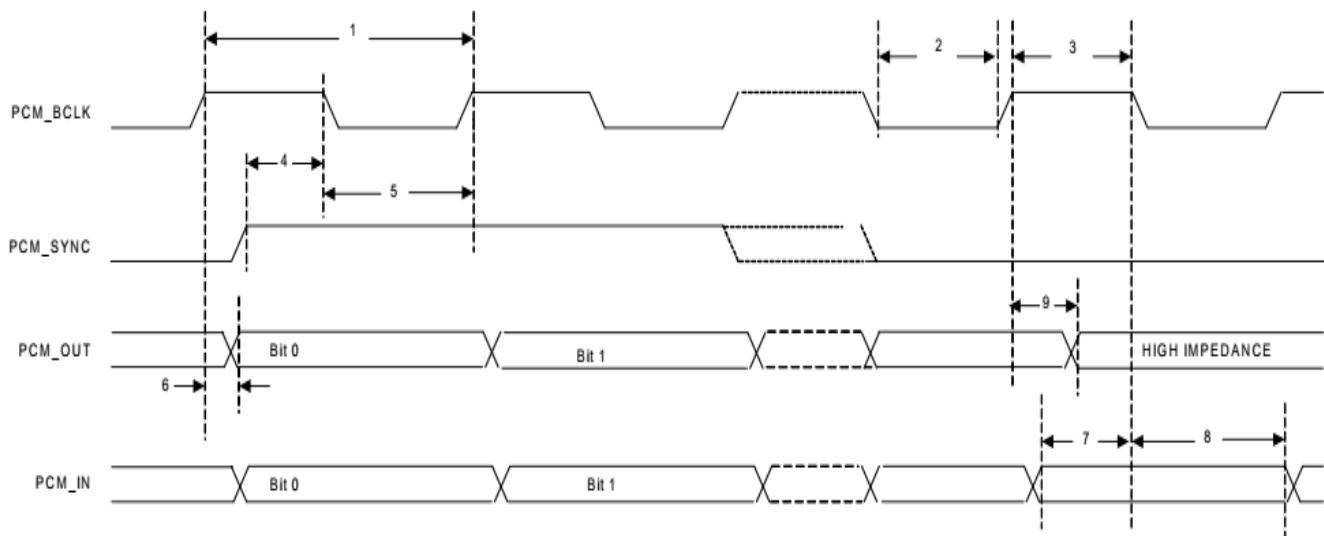


Figure 11: PCM timing specification – Long Frame Sync, Slave Mode

Table 33: PCM timing specification – Long Frame Sync, Slave Mode

Reference	Characteristics	Min.	Typ.	Max.	Unit
1	PCM bit clock frequency	-	-	12.0	MHz
2	PCM bit clock LOW	41.0	-	-	ns
3	PCM bit clock HIGH	41.0	-	-	ns
4	BT_PCM_SYNC setup	8.0	-	-	ns
5	BT_PCM_SYNC hold	8.0	-	-	ns
6	BT_PCM_OUT delay	0	-	25.0	ns
7	BT_PCM_IN setup	8.0	-	-	ns
8	BT_PCM_IN hold	8.0	-	-	ns
9	Delay from rising edge of BT_PCM_CLK during last bit period to BT_PCM_OUT becoming high impedance	0	-	25.0	ns

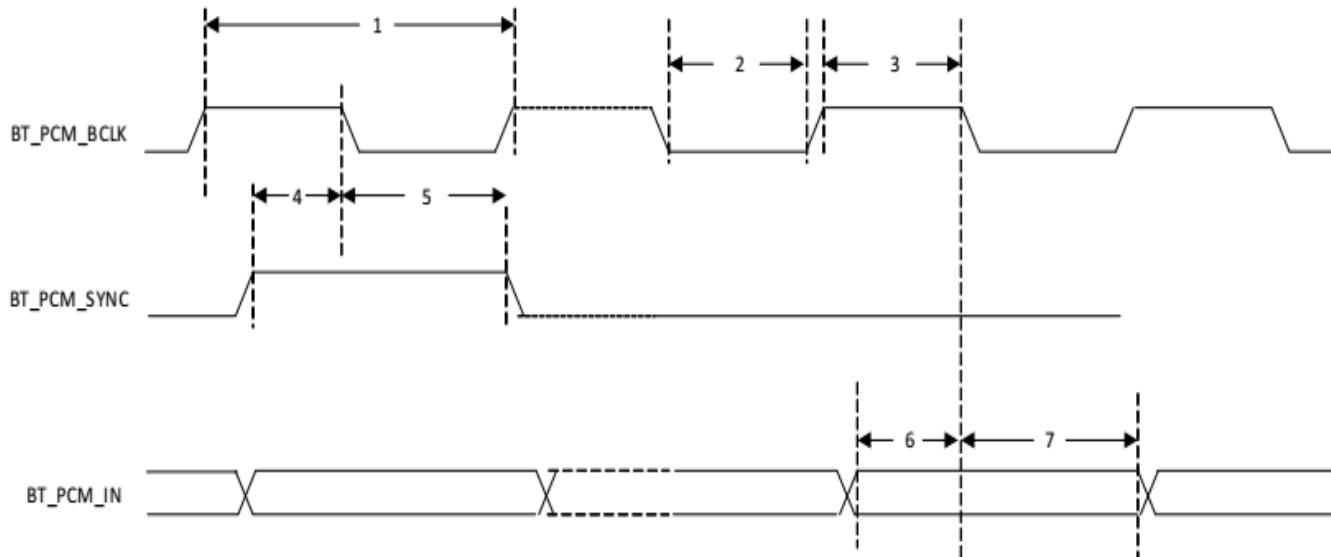


Figure 12: PCM timing specification – Short Frame Sync, Receive Only, Burst Mode

Table 34: PCM timing specification – Short Frame Sync, Receive Only, Burst Mode

Reference	Characteristics	Min.	Typ.	Max.	Unit
1	PCM bit clock frequency	-	-	24.0	MHz
2	PCM bit clock LOW	20.8	-	-	ns
3	PCM bit clock HIGH	20.8	-	-	ns
4	BT_PCM_SYNC setup	8.0	-	-	ns
5	BT_PCM_SYNC hold	8.0	-	-	ns
6	BT_PCM_IN setup	8.0	-	-	ns
7	BT_PCM_IN hold	8.0	-	-	ns

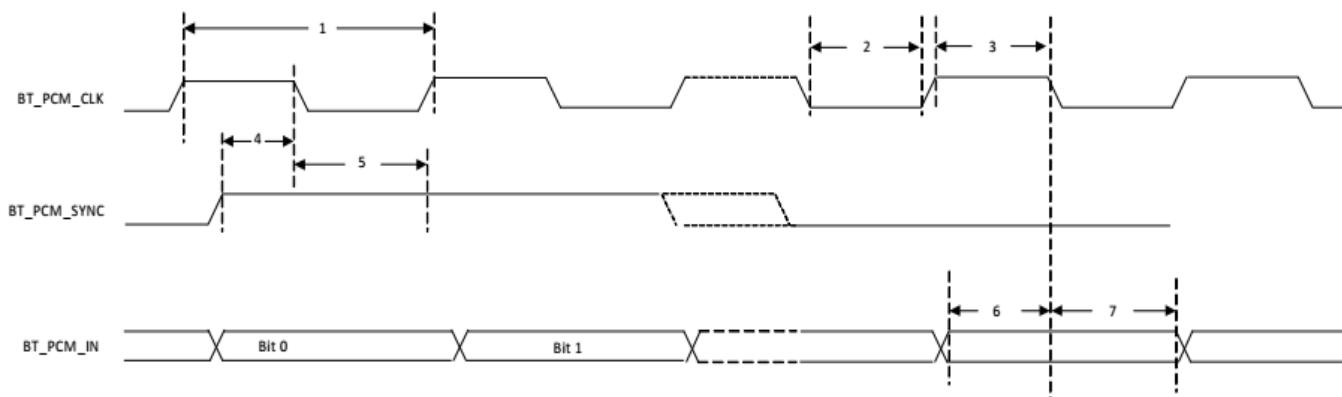


Figure 13: PCM timing specification – Long Frame Sync, Receive Only, Burst Mode

Table 35: PCM timing specification – Long Frame Sync, Receive Only, Burst Mode

Reference	Characteristics	Min.	Typ.	Max.	Unit
1	PCM bit clock frequency	-	-	24.0	MHz
2	PCM bit clock LOW	20.8	-	-	ns
3	PCM bit clock HIGH	20.8	-	-	ns
4	BT_PCM_SYNC setup	8.0	-	-	ns
5	BT_PCM_SYNC hold	8.0	-	-	ns
6	BT_PCM_IN setup	8.0	-	-	ns
7	BT_PCM_IN hold	8.0	-	-	ns

## 10.4 JTAG Interface

The Sona IF573 supports the JTAG interface for use with proprietary debug and characterization test tools during board bring-up.

**Note:** The JTAG interface is disabled by default and not exposed on the M.2 2230 E-Key interface.

## 11 POWER-UP SEQUENCE AND TIMING

Sona IF573 has two signals that allow the host to control power consumption by enabling or disabling the Bluetooth, WLAN, and internal regulator block.

### 11.1 Description of Control Signals

- **WL\_REG\_ON:** Used to power up the WLAN. When this pin is high, the internal regulators are enabled and the WLAN section is out of reset. When this pin is low the WLAN section is in reset. This signal is connected to the W\_DISABLE1# pin on the M.2 interface.
- **BT\_REG\_ON:** Used to power up the Bluetooth section. If both the BT\_REG\_ON and WL\_REG\_ON pins are low, the regulators are disabled. When this pin is low and WL\_REG\_ON is high, the Bluetooth section is in reset. This signal is connected to the W\_DISABLE2# pin on the M.2 interface.
- **M.2 1318 - VBAT and VDDIO should not rise 10% - 90% faster than 40 microseconds.**
- **M.2 1318 - VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.**
- Do not access the digital interface for at least 150 milliseconds after VDDC and VDDIO are available.

### 11.2 Control Signal Timing Diagrams

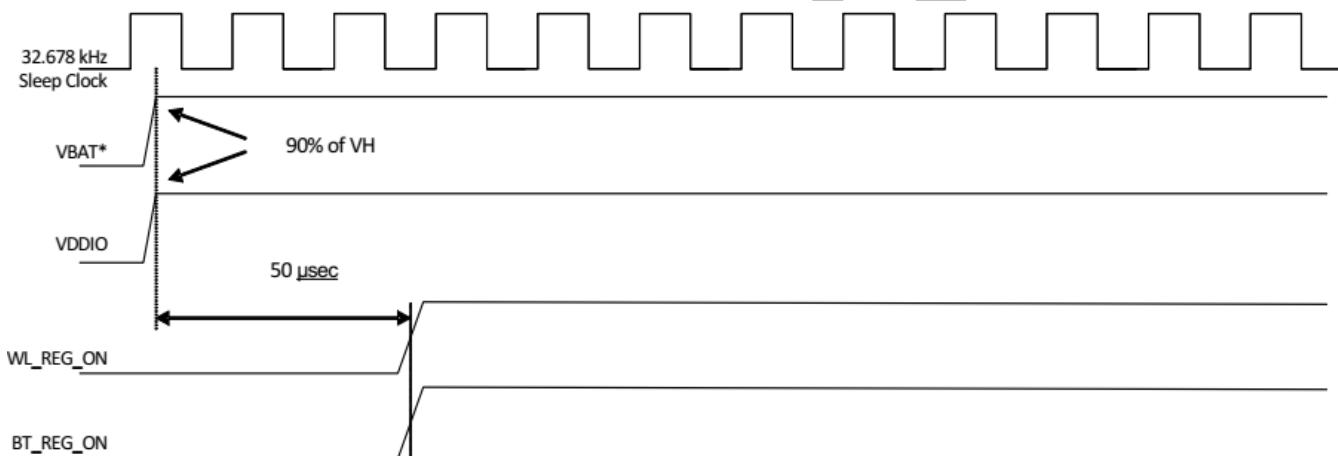


Figure 14: WL\_REG\_ON = ON, BT\_REG\_ON = ON

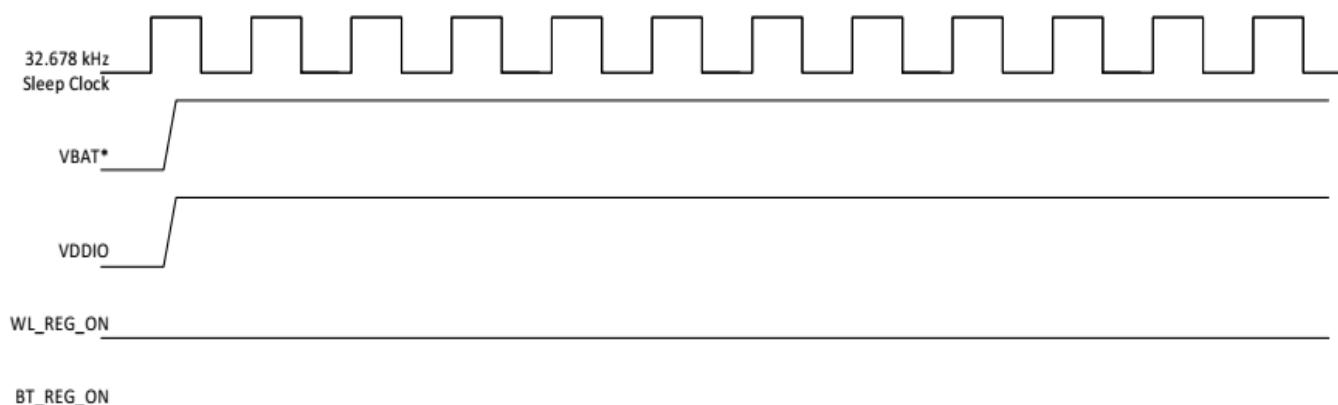


Figure 15: WL\_REG\_ON = OFF, BT\_REG\_ON = OFF

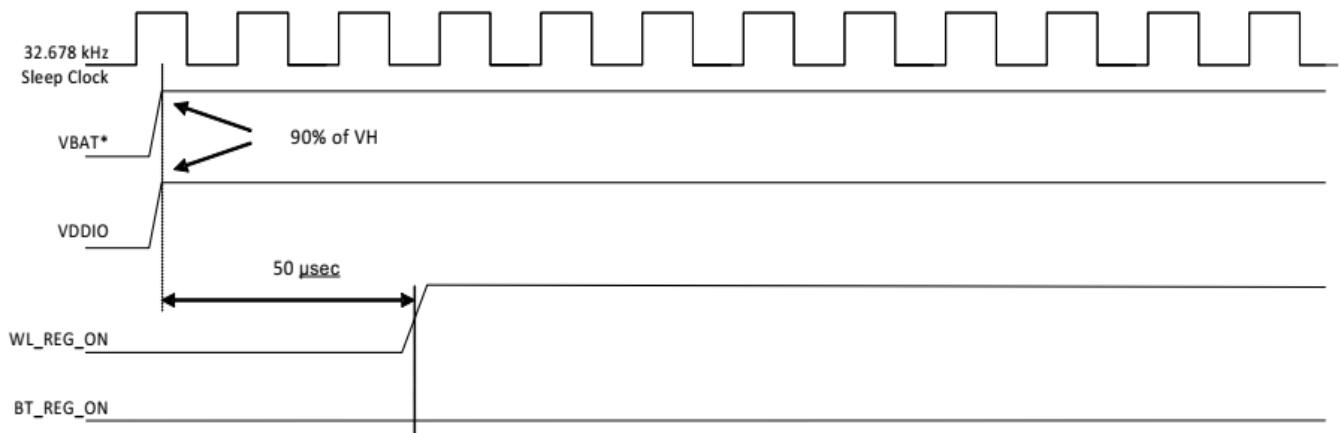


Figure 16: WL\_REG\_ON = ON, BT\_REG\_ON = OFF

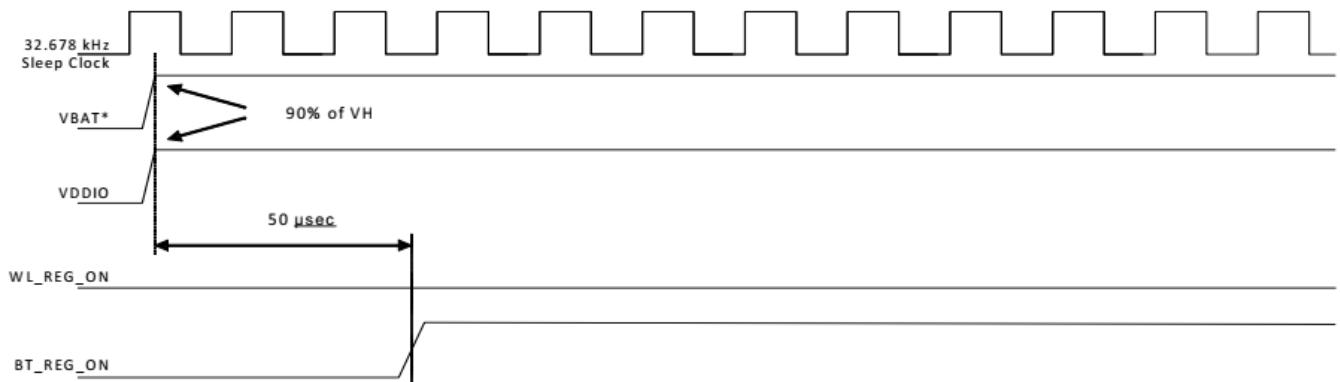


Figure 17: WL\_REG\_ON = OFF, BT\_REG\_ON = ON

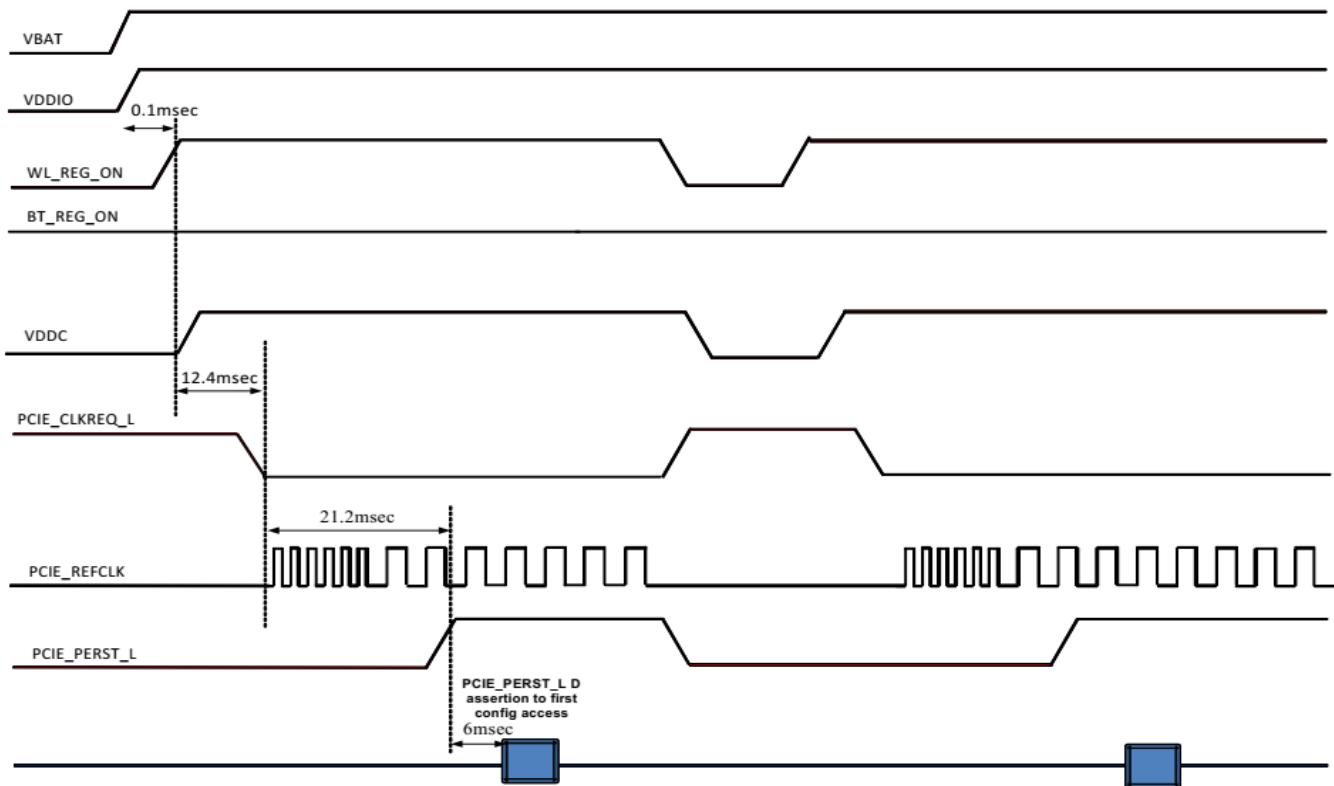


Figure 18: WLAN Power-Up Sequence for PCIe Host

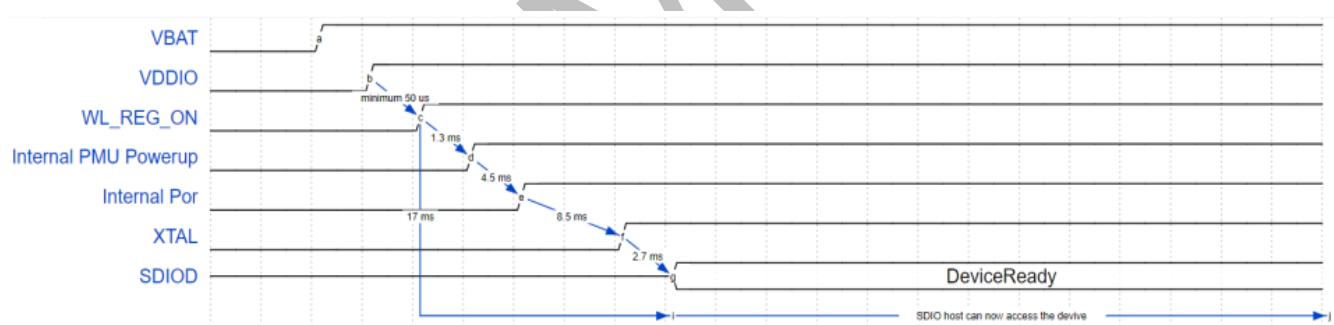


Figure 19: WLAN Boot-Up Sequence for SDIO Host

## 12 PIN DEFINITIONS

### 12.1 M.2 1318 Solder-down

Table 36: M.2 1318 pin definitions

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
1	UIM_POWER_SRC/GPIO1	-	-	NA	-
2	UIM_POWER_SNK	-	-	NA	-
3	UIM_SWP	-	-	NA	-
4	3.3V	PWR	3.3V	Power Supply Input	-
5	3.3V	PWR	3.3V	Power Supply Input	-
6	GND	-	-	Ground	GND
7	RESERVED	-	-	NA	-
8	ALERT	-	-	NA	-
9	I2C_CLK	-	-	NA	-
10	I2C_DATA	-	-	NA	-
11	COEX_RXD	I	VDDIO	WLAN_JTAG_TMS	NC
12	COEX_TXD	I	VDDIO	WLAN_JTAG_TCK	NC
13	COEX3	I	VDDIO	WLAN_JTAG_TDI	NC
14	SYSCLK/GNSS_0	-	-	NA	-
15	TX_BLANKING/GNSS_1	-	-	NA	-
16	RESERVED	-	-	NA	-
17	GND	-	-	Ground	GND
18	RESERVED	I	VDDIO	<ul style="list-style-type: none"> <li>▪ SDIO mode: WL_DEV_WAKE</li> <li>▪ PCIe mode: Reserved</li> </ul>	NC
19	RESERVED	O	VDDIO	WLAN_JTAG_TDO	NC
20	GND	-	-	Ground	GND
21	RESERVED	I	VDDIO	Reserved	NC
22	RESERVED	I	VDDIO	<ul style="list-style-type: none"> <li>▪ PCIe mode: WL_DEV_WAKE</li> <li>▪ SDIO mode: Reserved</li> </ul>	NC
23	GND	-	-	Ground	GND
24	GPIO_1	I	VDDIO	WLAN Interface Select <ul style="list-style-type: none"> <li>▪ Pull to VDDIO for PCIe</li> <li>▪ Pull to GND for SDIO</li> </ul>	-
25	RESERVED	I	VDDIO	JTAG_SEL Reserved <b>Must be pulled to GND for normal operation</b>	GND
26	GND	-	-	Ground	GND
27	SUSCLK(32kHz)	I	VDDIO	External Sleep Clock (32.768 kHz) <b>This clock must be provided</b>	-

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
28	W_DISABLE1#	I	VDDIO	This pin controls the internal WL_REG_ON signal and has an internal 200K pull-down.  <b>This pin must be driven/pulled high to enable WLAN</b>  Recommend controlling this signal via host GPIO for optimal power control.	NC
29	PEWAKE#	O	VBAT	PCI power management event output. Used to request a change in the device or system power state. The assertion and de-assertion of this signal are asynchronous to the PCIe reference clock.	NC
30	CLKREQ#	O	VBAT	PCIe clock request signal which indicates when the REFCLK to the PCIe interface can be gated. <ul style="list-style-type: none"> <li>▪ 1 = the clock can be gated.</li> <li>▪ 0 = the clock is required.</li> </ul>	NC
31	PERST#	I	VBAT	PCIe System Reset	NC
32	GND	-	-	Ground	GND
33	REFCLKn0	I	VBAT	PCIE Differential Pair Clock Source (100 MHz) Negative Input.	NC
34	REFCLKp0	I	VBAT	PCIE Differential Pair Clock Source (100 MHz) Positive Input.	NC
35	GND	-	-	Ground	GND
36	PETn0	O	VBAT	PCIE Transmitter Differential Pair Negative Output	NC
37	PETp0	O	VBAT	PCIE Transmitter Differential Pair Positive Output	NC
38	GND	-	-	Ground	GND
39	PERn0	I	VBAT	PCIE Receiver Differential Pair Negative Input	NC
40	PERp0	I	VBAT	PCIE Receiver Differential Pair Positive Input	NC
41	GND	-	-	Ground	GND
42	VENDOR DEFINED	PWR	VDDIO	1.8V IO Supply for all digital I/O	-
43	VENDOR DEFINED	-	-	NA	-
44	VENDOR DEFINED	-	-	NA	-
45	SDIO RESET#	-	-	NA	-
46	SDIO WAKE#	O	VDDIO	WL_HOST_WAKE Reserved	NC
47	SDIO DATA3	I/O	VDDIO	SDIO Data line 3	NC
48	SDIO DATA2	I/O	VDDIO	SDIO Data line 2	NC
49	SDIO DATA1	I/O	VDDIO	SDIO Data line 1	NC
50	SDIO DATA0	I/O	VDDIO	SDIO Data line 0	NC
51	SDIO CMD	I/O	VDDIO	SDIO command line	NC
52	SDIO CLK	I	VDDIO	SDIO Clock Input	NC
53	UART WAKE#	O	VDDIO	BT_HOST_WAKE Reserved	NC

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
54	UART_CTS	I	VDDIO	BT UART CTS <b>Hardware handshake is required</b>	-
55	UART_Tx	O	VDDIO	BT UART Transmit	-
56	UART_Rx	I	VDDIO	BT UART Receive	-
57	UART_RTS	O	VDDIO	BT UART RTS <b>Hardware handshake is required</b>	-
58	PCMFR1	I/O	VDDIO	BT_PCM Sync. Master mode: Generated by radio Slave mode: Generated by external host	NC
59	PCMIN	I	VDDIO	BT_PCM data input.	NC
60	PCMOUT	O	VDDIO	BT_PCM data output	NC
61	PCMCLK	I/O	VDDIO	BT_PCM Clock Master mode: Generated by radio Save mode: Generated by external host	NC
62	GND	-	-	Ground	GND
63	W_DISABLE2#	I	VDDIO	This pin controls the internal BT_REG_ON signal and has an internal 200K pull-down. <b>This pin must be controlled by host GPIO</b>	NC
64	LED_2#	I/O	VDDIO	Reserved	NC
65	LED_1#	I/O	VDDIO	BT Interface Select/GPIO_12 <b>This pin must be pulled high</b>	-
66	RESERVED	I	VDDIO	BT_DEV_WAKE Reserved	NC
67	RESERVED	I	VDDIO	WLAN_JTAG_TRST Reserved	NC
68	GND	-	-	Ground	GND
69	USB_D-	-	-	NA	NC
70	USB_D+	-	-	NA	NC
71	GND	-	-	Ground	GND
72	3.3V	PWR	3.3V	Power Supply Input	-
73	3.3V	PWR	3.3V	Power Supply Input	-
74~ 78	GND	-	-	Ground	GND
79	BT_S	-	-	Bluetooth RF for trace antenna variant Unused for MHF4 antenna connector variant	-
80~ 85	GND	-	-	Ground	GND
86	WL_C0	-	-	WLAN RF Antenna 0 for trace antenna variant Unused for MHF4 antenna connector variant	WLAN RF Antenna 0 for trace antenna variant Unused for MHF4 antenna connector variant
87~ 93	GND	-	-	Ground	GND
94	WL_C1	-	-	WLAN RF Antenna 1 for trace antenna variant Unused for MHF4 antenna connector variant	WLAN RF Antenna 1 for trace antenna variant Unused for MHF4 antenna connector variant

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
95~ 96	GND	-	-	Ground	GND
G1~ G10	GND	-	-	Ground	GND

## 12.2 M.2 2230 E-Key

Table 37: M.2 2230 E-Key pin definitions

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
1	GND	-	-	Ground	GND
2	3.3V	PWR	3.3V	DC supply voltage for module.	-
		I/P		Operational is 3.13V to 3.6V	
3	USB_D+	-	-	NA	NC
4	3.3V	PWR	3.3V	DC supply voltage for module.	-
		I/P		Operational is 3.13V to 3.6V	
5	USB_D-	-	-	NA	NC
6	LED1#	I/O	3.3V	GPIO_12 Reserved	NC
7	GND	-	-	Ground	GND
8	PCM_CLK	I/O	1.8V	PCM clock. Can be master (Output) or slave (Input)	NC
9	SDIO CLK	I	1.8V	SDIO clock input	NC
10	PCM_SYNC	I/O	1.8V	PCM Sync. Can be master (Output) or slave (Input)	NC
11	SDIO CMD	I/O	1.8V	SDIO command line	NC
12	PCM_OUT	O	1.8V	PCM data output.	NC
13	SDIO DATA0	I/O	1.8V	SDIO data lin0	NC
14	PCM_IN	I	1.8V	PCM data input.	NC
15	SDIO DATA1	I/O	1.8V	SDIO data lin1	NC
16	LED2#	I/O	3.3V	GPIO_13 Reserved	NC
17	SDIO DATA2	I/O	1.8V	SDIO data lin2	NC
18	GND	-	-	Ground	GND
19	SDIO DATA3	I/O	1.8V	SDIO data lin3	NC
20	UART_WAKE#	O	3.3V	BT_HOST_WAKE Reserved	NC
21	SDIO_WAKE#	O	1.8V	WL_HOST_WAKE Reserved	NC
22	UART_TXD	O	1.8V	BT UART Transmit	NC
23	SDIO RESET#	-	-	NC	NC
32	UART_RXD	I	1.8V	BT UART Receive	NC
33	GND	-	-	Ground	GND

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
34	UART_RTS	O	1.8V	BT UART RTS <b>Hardware handshake is required</b>	NC
35	PERp0	I	3.3V	PCIE Receiver Differential Pair Positive Input	NC
36	UART_CTS	I	1.8V	BT UART CTS <b>Hardware handshake is required</b>	NC
37	PERn0	I	3.3V	PCIE Receiver Differential Pair Negative Input	NC
38	VENDER DEFINED38	O	1.8V	WLAN_JTAG_TDO Reserved	NC
39	GND	-	-	Ground	GND
40	VENDER DEFINED40	I	1.8V	WL_DEV_WAKE Reserved	NC
41	PETp0	O	3.3V	PCIE Transmitter Differential Pair Positive Output	NC
42	VENDER DEFINED42	I	1.8V	BT_DEV_WAKE Reserved	NC
43	PETn0	O	3.3V	PCIE Transmitter Differential Pair Negative Output	NC
44	COEX3	I	1.8V	WLAN_JTAG_TDI Reserved	NC
45	GND	-	-	Ground	GND
46	COEX2	I	1.8V	WLAN_JTAG_TCK Reserved	NC
47	REFCLKp0	I	1.8V	PCIE Differential Pair Clock Source (100 MHz) Positive Input.	NC
48	COEX1	I	1.8V	WLAN_JTAG_TMS Reserved	NC
49	REFCLKn0	I	3.3V	PCIE Differential Pair Clock Source (100 MHz) Negative Input.	NC
50	SUSCLK	I	3.3V	External Sleep Clock (32.768 kHz) <b>This clock must be provided</b>	-
51	GND	-	-	Ground	GND
52	PERST0#	I	3.3V	PCIe System Reset	NC
53	CLKREQ0#	O	3.3V	PCIe clock request signal which indicates when the REFCLK to the PCIe interface can be gated.	NC
54	W_DISABLE2#	I	3.3V	This pin controls the internal BT_REG_ON signal and has a 10K pull-up on the M.2 2230 module. <b>This pin must be controlled by host GPIO</b>	NC
55	PEWAKE0#	O	3.3V	PCI power management event output. Used to request a change in the device or system power state. The assertion and deassertion of this signal is asynchronous to the PCIe reference clock.	NC
56	W_DISABLE1#	I	3.3 V	This pin controls the internal WL_REG_ON signal and has a 10K pull-up on the M.2 2230 module. Recommend controlling this signal via host GPIO for optimal power control.	NC

Pin #	Name	Type	Voltage Ref.	Function	If Not Used
57	GND	-	-	Ground	GND
58	I2C DATA	-	-	NC	NC
59	RESERVED	-	-	NC	NC
60	I2C CLK	-	-	NC	NC
61	RESERVED	-	-	NC	NC
62	ALERT#	-	-	NC	NC
63	GND	-	-	Ground	GND
64	RESERVED	-	-	NC	NC
65	RESERVED	-	-	NC	NC
66	UIM_SWP	-	-	NC	NC
67	RESERVED	-	-	NC	NC
68	UIM_POWER_SNK	-	-	NC	NC
69	GND	-	-	Ground	GND
70	UIM_POWER_SRC	-	-	NC	NC
71	RESERVED	-	-	NC	NC
72	3.3V	PWR	3.3V I/P	DC supply voltage for module. Operational is 3.13V to 3.6V	--
73	RESERVED	-	-	NC	NC
74	3.3V	PWR	3.3V I/P	DC supply voltage for module. Operational is 3.13V to 3.6V	--
75	GND	-	-	Ground	GND

**Note** The transmit/receive differential pairs of the PCIe bus include "PERp0", "PERn0", "PETp0" and "PETn0", which have a built-in decoupling capacitor.

## 13 HOST PLATFORM IMPLEMENTATION DETAILS

### 13.1 M.2 1318 WLAN Interface Selection

The Sona IF573 M.2 1318 module must be configured for either PCIe or SDIO WLAN interface. Configuration is done with resistor strapping as specified in [Table 38](#).

**Table 38: Wi-Fi host interface configuration table**

WLAN/Bluetooth Interface	GPIO_1 (Pin24)	LED_1# (Pin 65)
PCIe / UART	H	H
SDIO /UART	L	H

**Note:** The M.2 2230 E-Key module strapping is implemented on the M.2 carrier board.

### 13.2 Bluetooth Interface Requirements

The CYW55573 Bluetooth CPU core requires the UART\_CTS input to be held low at the point the BT\_REG\_ON (W\_DISABLE2#) signal goes high to enable secure firmware download. In addition, the HCI interface uses the standard H4 protocol which requires four-wire hardware handshaking.

This requires that the host implement GPIO control over BT\_REG\_ON/W\_DISABLE2# and implement full RTS/CTS handshaking.

### 13.3 Low Power Clock

The Sona IF573 requires a 32KHz clock on the SUSCLK input. This clock drives various internal state machines and must be provided by the host even if low power operation is not needed.

### 13.4 M.2 1318 WL\_DEV\_WAKE Mapping

The WL\_DEV\_WAKE feature is mapped to different pins on the M.2 1318 module depending on the WLAN interface selection. See [Table 39](#) for details.

**Table 39: M.2 1318 WL\_DEV\_WAKE Mapping**

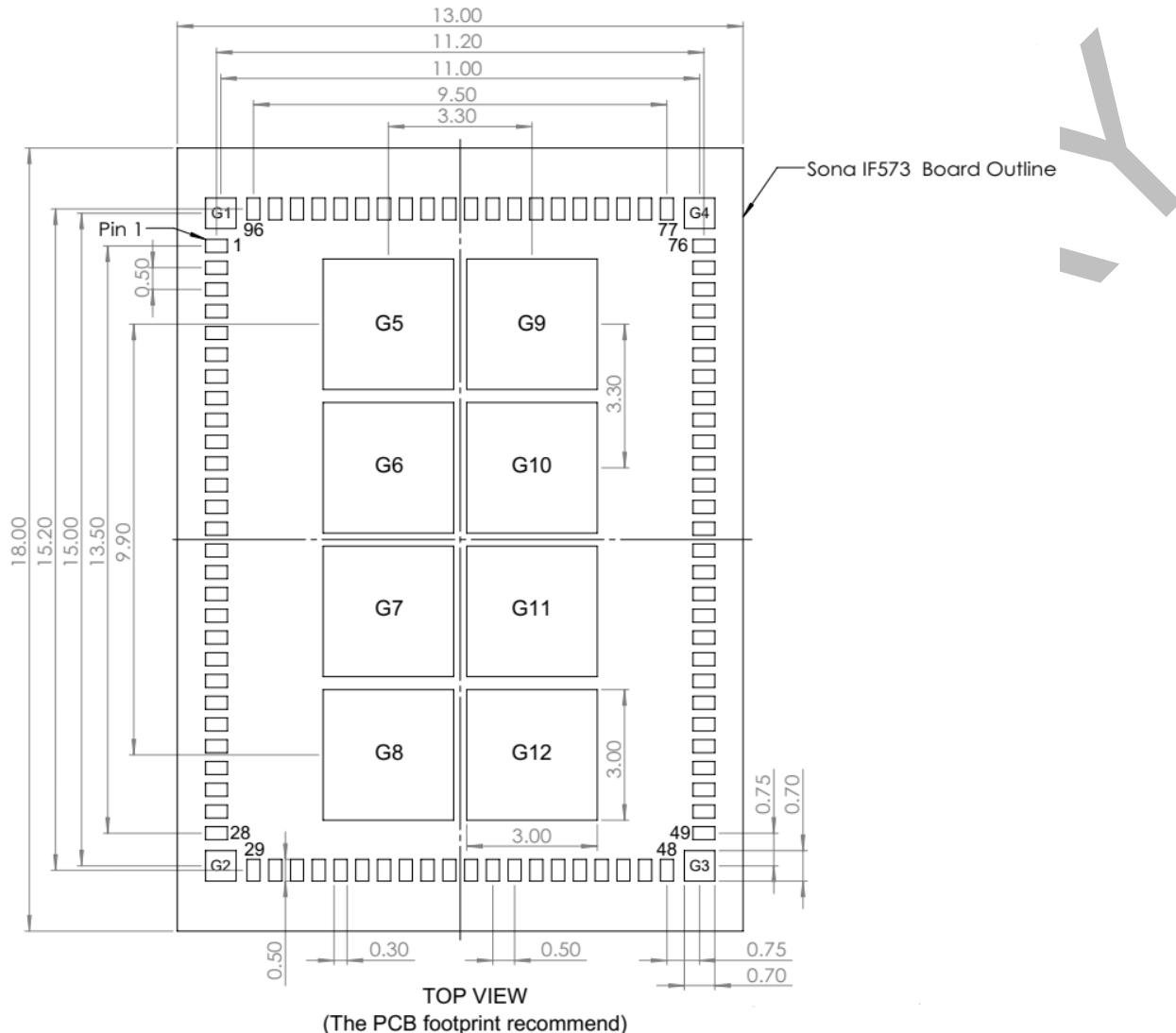
WLAN Interface	M.2 1318 Pin	Internal GPIO
PCIe	22	GPIO_8
SDIO	18	LHL_GPIO1

**Note:** This feature is subject to software support and not currently implemented.

## 14 MECHANICAL SPECIFICATIONS

### 14.1 M.2 1318

Module dimensions of Sona IF573 M.2 1318 package is 18 x 13 x 1.9 mm. Detailed drawings are shown in [Figure 20](#)



**Figure 20: M.2 1318**

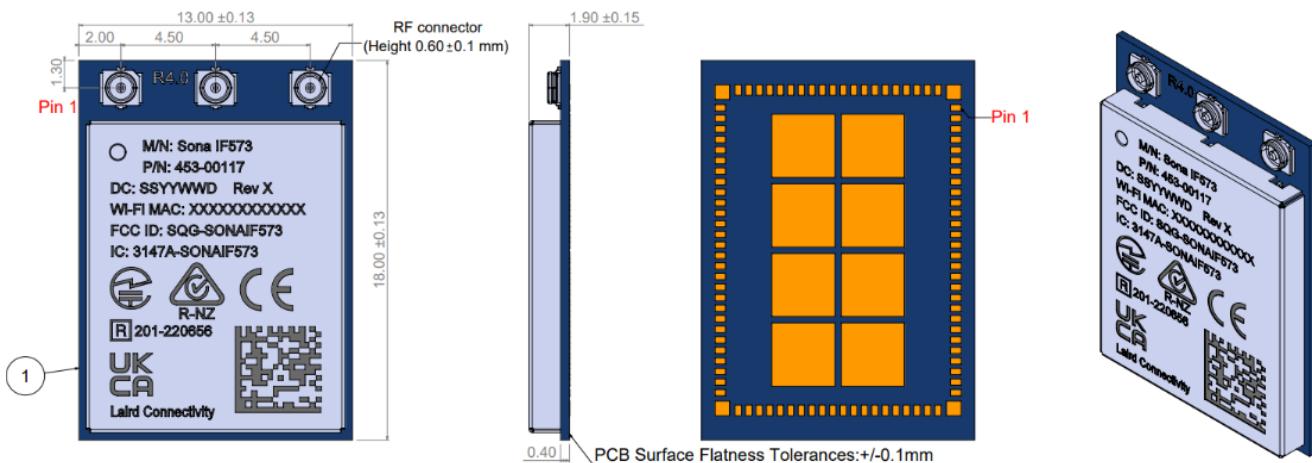


Figure 21: M.2 1318 (MHF4 variant) – Top View

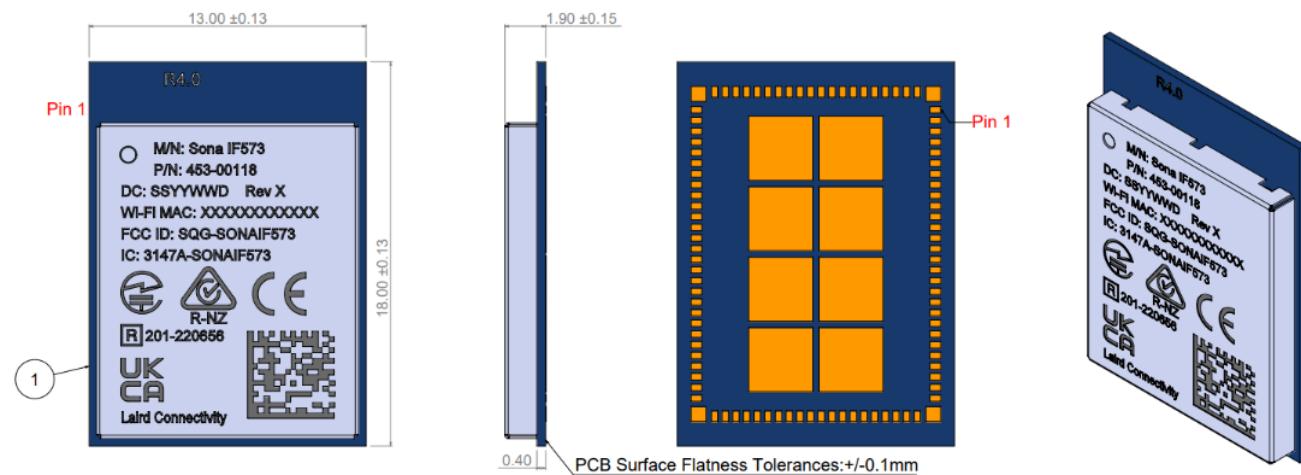
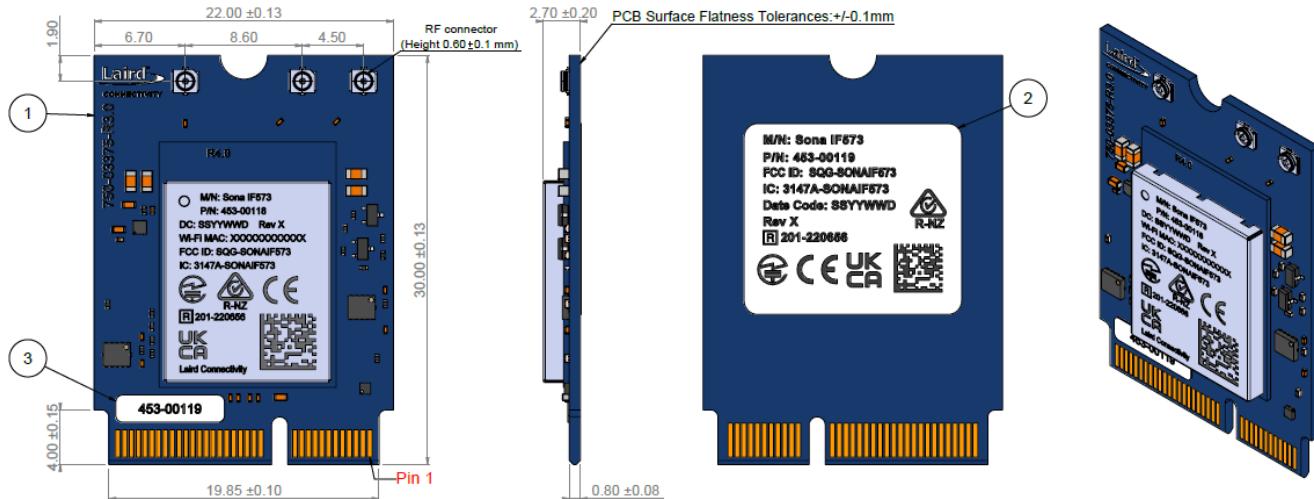


Figure 22: M.2 1318 (trace antenna variant) – Top View

## 14.2 M.2 2230 E-Key

Module dimensions of Sona IF573 M.2 2230 E-Key module is 22 x 30 x 2.7 mm. Detailed drawings are shown in [Figure 23](#).



**Figure 23: Sona IF573 M.2 2230**

- Note:** The Wi-Fi MAC address is located on the product label.  
The last digit of Wi-Fi MAC address is assigned to either 0, 2, 4, 6, 8, A, C, E.  
The BT MAC address is the Wi-Fi MAC address plus 1.

## 14.3 M.2 2230 E-Key Mounting

The Sona IF573 M.2 2230 E-Key module connects to the host via a standard PCI EXPRESS M2 connector.

Kyocera's 6411 series provides 1.8mm, 2.3mm and 3.2mm connector heights. JAE's SM3 series provides 1.2mm, 2.15mm, 3.1mm and 4.1mm connector heights.

The Sona IF573 M.2 2230 E-Key module is a single-sided component module so we recommend the connectors listed in [Table 40](#).

**Table 40: Recommended M.2 2230 E-Key Connectors**

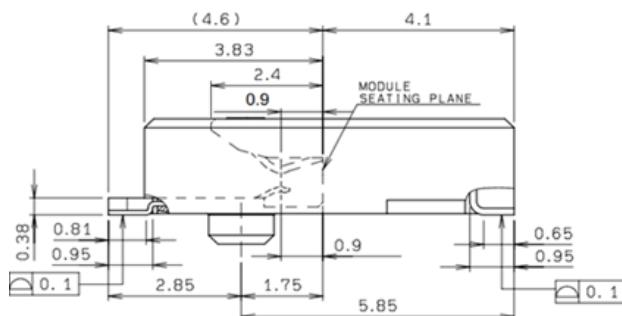
M.2 Key-E Connector	Connector Height
KYOCERA 24-6411-067-101-894E	2.3 mm
JAE SM3ZS067U310AERxxxx	3.1 mm

The corresponding standoffs are listed in [Table 41](#).

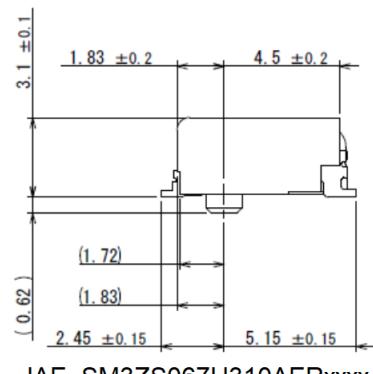
**Table 41: Recommended M.2 E-Key Standoffs**

M.2 Key-E Connector	Stand-off
KYOCERA 24-6411-067-101-894E	EMI STOP F50M16-041525P1D4M
JAE SM3ZS067U310AERxxxx	JAE SM3ZS067U310-NUT1-Rxxxx

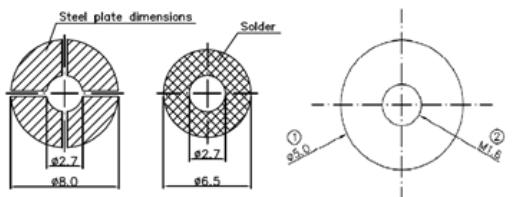
Detailed layout and stencil opening are show in [Figure 24](#).



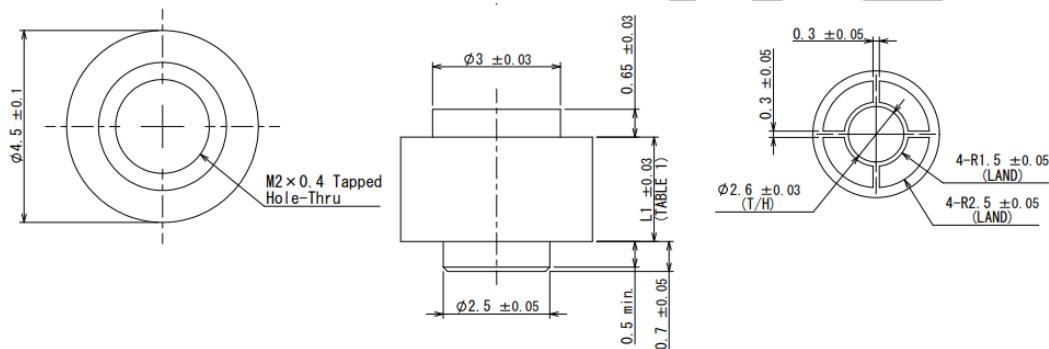
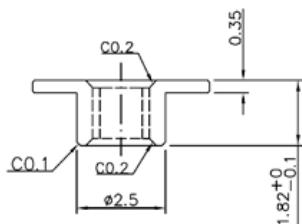
KYOCERA 24-6411-067-101-894E



JAE SM3ZS067U310AERxxxx



EMI STOP F50M16-041525P1D4M



JAE SM3ZS067U310-NUT1-Rxxxx

Figure 24: M.2 2230 E-Key connector/standoff mounting

## 15 RF LAYOUT DESIGN GUIDELINES

The following is a list of RF layout design guidelines and recommendation when installing a Laird Connectivity radio into your device.

- Do not run antenna cables directly above or directly below the radio.
- Do not place any parts or run any high-speed digital lines below the radio.
- Ensure that there is the maximum allowable spacing separating the antenna connectors on the Laird Connectivity radio from the antenna. In addition, do not place antennas directly above or directly below the radio.
- Laird Connectivity recommends the use of a double-shielded cable for the connection between the radio and the antenna elements.
- Be sure to put a 10uF/16V/0603 capacitor on EACH 3.3V power pin. Place the capacitor as close as possible to the pin to ensure correct PMU operation.
- Use proper electro-static-discharge (ESD) procedures when installing the Laird Connectivity radio module. To avoid negatively impacting Tx power and receiver sensitivity, do not cover the antennas with metallic objects or components.

## 16 APPLICATION NOTES

### 16.1 Introduction

Laird Connectivity's surface mount modules are designed to conform to all major manufacturing guidelines. This application note is intended to provide additional guidance beyond the information that is presented in the user manual. This application note is considered a living document and will be updated as new information is presented.

The modules are designed to meet the needs of several commercial and industrial applications. They are easy to manufacture and conform to current automated manufacturing processes.

## 16.2 Shipping and Labelling

### 16.2.1 M.2 1218 Solder-Down

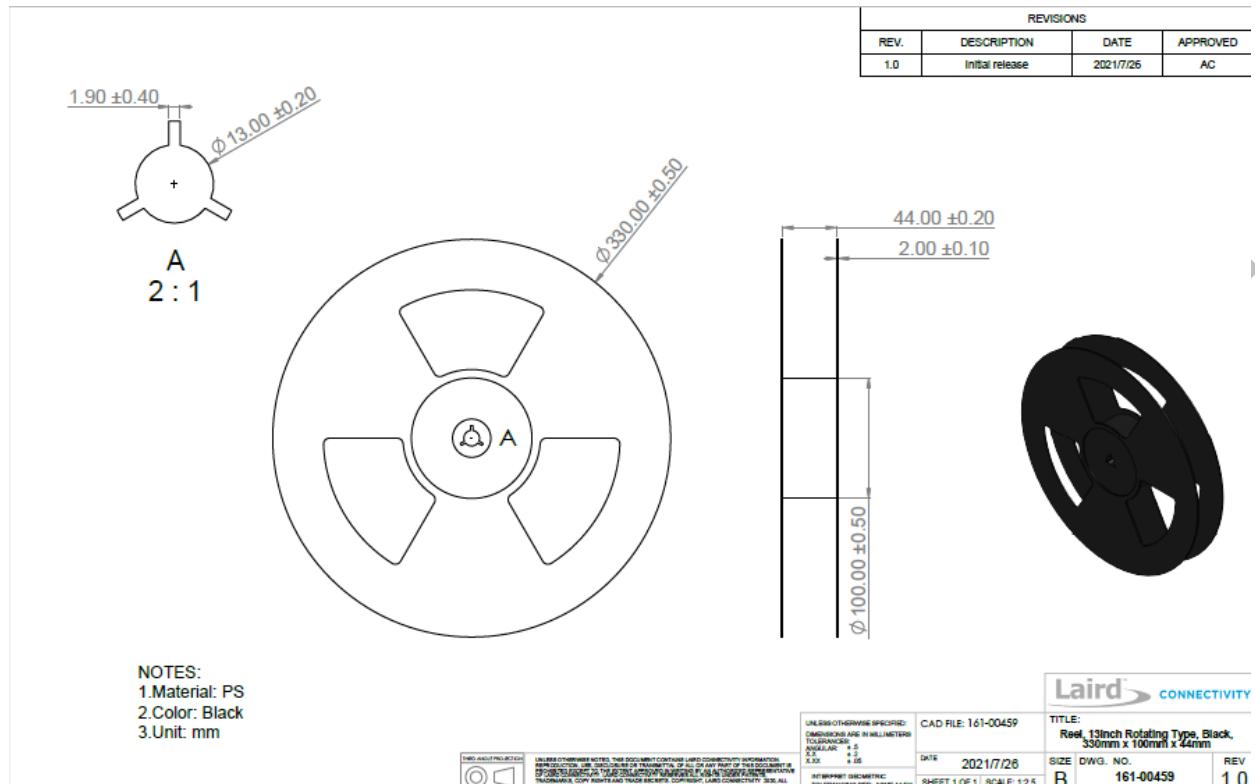


Figure 25: Sona IF573 Reel specifications, 161-00459: Sona IF573 Reel specifications, 161-00459

ITRM	A0	B0	K0	P0	P1	P2	T	E	F	D0	D1	W	10P0	S0
DIM	13.40	18.40	2.40	4.00	20.00	2.00	0.30	1.75	20.20	1.50	2.00	44.00	40.00	40.40
TOLE	±0.10	±0.10	±0.10	±0.10	±0.10	±0.15	±0.05	±0.10	±0.15	+0.10 -0.00	±0.10	±0.30	±0.20	±0.10

REVISIONS			
REV.	DESCRIPTION	DATE	APPROVED
1.0	Initial release	Oct 11, 2022	AC

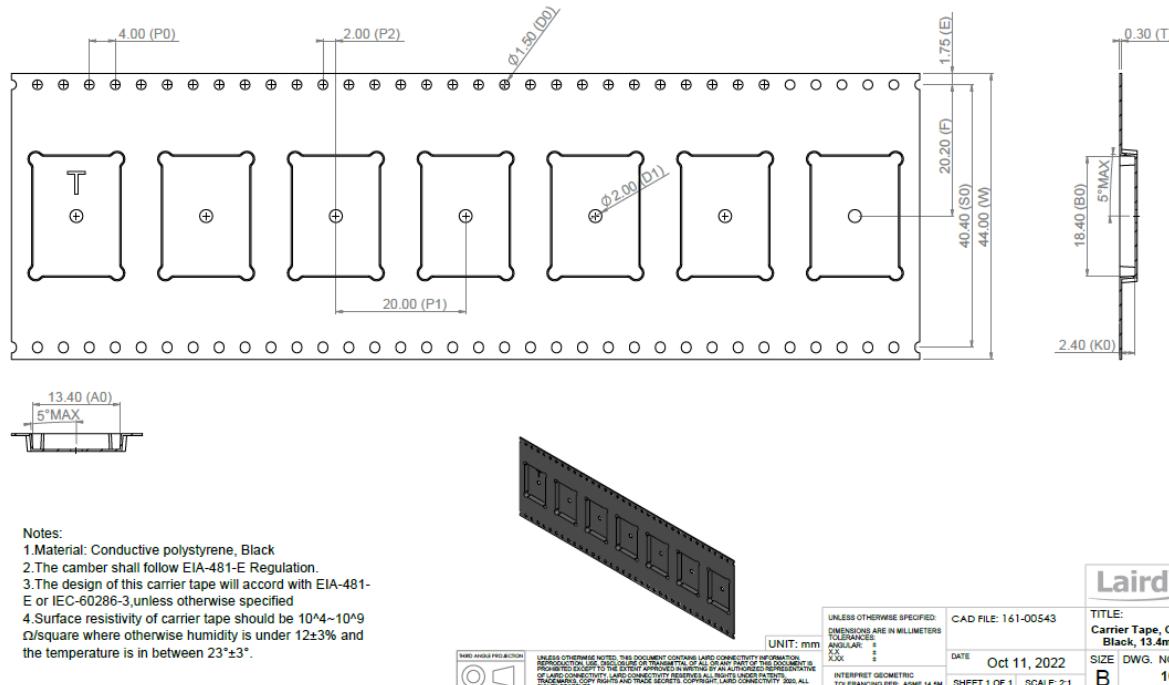


Figure 26: Sona IF573 Tape specifications, 161-00543

There are 1,000 Sona IF573 modules taped in a reel (and packaged in a pizza box) and three boxes per carton (3,000 modules per carton). Reel, boxes, and carton are labeled with the appropriate labels. See Figure 27 for more information.

UNIT: mm	CAD FILE: 161-00543	TITLE: Carrier Tape, Conductive Polystyrene, Black, 13.4mm x 18.4mm x 2.4mm
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS ANGULAR: ° LINEAR: ± ZXX	DATE: Oct 11, 2022	SIZE DWG. NO. B REV. 1.0
INTERPRET GEOMETRIC TOLERANCING PER: ASME Y14.5M SHEET 1 OF 1   SCALE: 2:1		

ITEM NO.	PART NUMBER	REV.	DESCRIPTION	QTY.	REVISIONS
					REV. DESCRIPTION DATE APPROVED
					1.0 Initial release Oct 19, 2022 AC
1	453-00117	1.0	Module, Sona IF573, MIMO, MHF4	1000	
2	161-00543	1.0	Carrier Tape, Conductive Polystyrene, Black, 13.4mm x 18.4mm x 2.4mm	1	
3	161-00528	1.0	Cover Tape, Anti-static Polyester, 37.5mm x 0.05mm	1	
4	161-00506	1.0	Desiccant, Silica Gel, 66g, 110mm x 120mm	1	
5	161-00510	1.0	Humidity Indicator Card, Minimum 50% RH, Three Spot Indication, 75mm x 50mm, J-STD-033 Rev D	1	
6	161-00544	1.0	Bag, ESD and Moisture Barrier, Silver, 420mm x 475mm x 0.15mm	1	
7	160-02008	1.1	Label, Blank Moisture Sensitivity Level, 4in x 4in	1	
8	161-00507	1.0	Box, Single-Wall Corrugated E Flute, 362mm x 344mm x 83mm	1	
9	161-00459	1.0	Reel, 13inch Rotating Type, Black, 330mm x 100mm x 44mm	1	
10	161-00508	1.0	Carton, AB Flute, 365mm x 383mm x 279mm	1	
11	160-02371	1.0	Label, Product Identifier, Sona IF573, 89mm x 51mm	3	
12	160-02372	1.0	Label, Carton Product Identifier, Sona IF573, 101mm x 64mm	2	

Notes:  
1.Put the Module in the carrier tape and cover the tape.  
2.Put the Reel, Desiccant and Humidity Indicator Card in the ESD bag.  
3.Put the packed ESD bag (vacuum) in the box.  
4.Module packaging quantity:  
Per Reel: 1000 PCS

UNIT: mm	CAD FILE: 453-00117R
UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS TOLERANCES AND PLAN: ... XXX : ...	TITLE: Module, Sona IF573, MIMO, MHF4, Tape and Reel
DATE: Oct 19, 2022	SIZE DWG. NO. B REV. 1.0
INTERPRET GEOMETRIC TOLERANCING PER: ASME Y14.5M	SHEET 1 OF 1 SCALE: 1:1

Figure 27: Sona IF573 packaging processes, 453-00117R

The following labels are located on the antistatic bag.

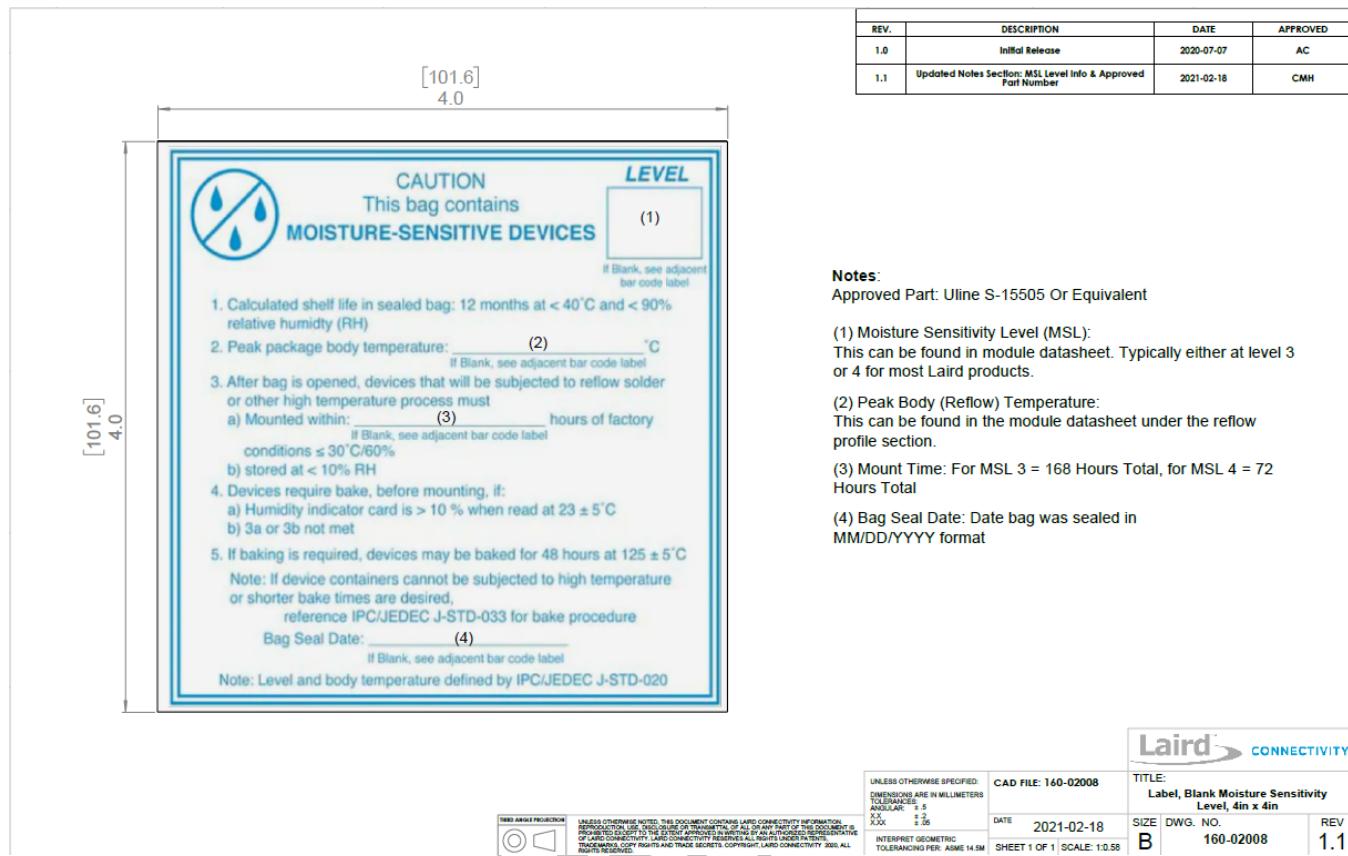


Figure 28: Sona IF573 Moisture Sensitivity Level Label, 160-02008

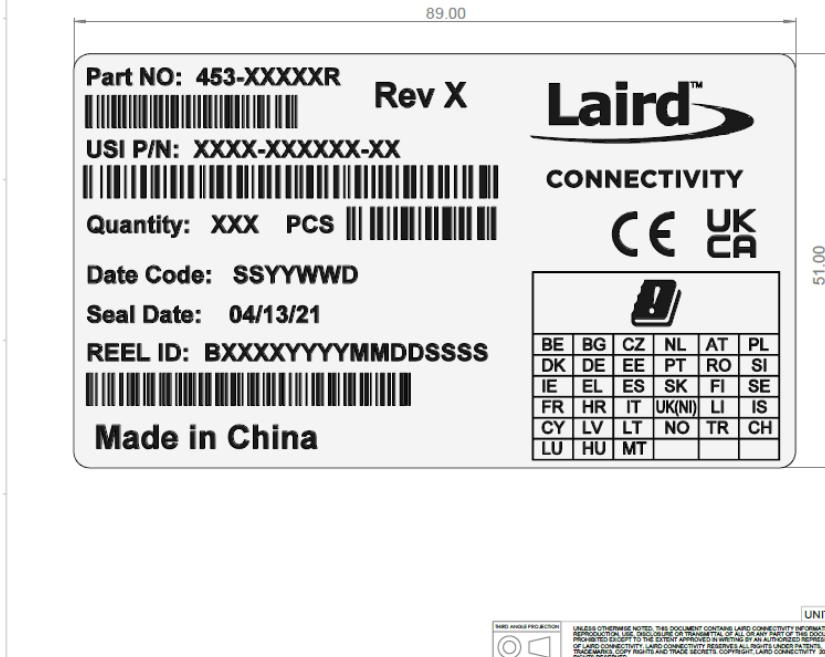
ITEM NO.	PART NUMBER	REV.	DESCRIPTION	QTY.	REVISIONS
1	168-00065	1.0	Label Stock, Art Paper, White, 89mm x 51mm	1	REV. DESCRIPTION DATE APPROVED 1.0 Initial release Oct 18, 2022 AC
					
<p>Notes:      1.Material: Art paper, White      2.Font: Arial</p> <p>Label info:      1.Part NO: Refer to the PO part number      (Refer to the table as right)      2.USI P/N: Supplier part number      3.Quantity: According to the actual quantity      4.Rev X: X-The major revision of the ordering part number      which can be found on the PO      5.Date Code: SSYYWW      SS: manufacturer number      YY: last two numbers of the year      WW: Week number of the year      D: Sun=1,Mon=2,Tue=3,Wed=4,Thu=5,Fri=6,Sat=7      6.Seal Date: According to the actual date      7.Reel ID: BXXXXYYYYMMDDSSSS      B: Represent BOX LABEL      XXXX: Computer Code      YYYY: Year      MM: Month      DD: Date      SSSS: Serial number      8.Barcode Type: Code 128      9.Country of origin      10.CE logo, Size: height 5mm      11.UKCA logo, Size: 5x5mm      12.CE 5GHz pictogram</p>					
					

Figure 29: Sona IF573 Bag and Box Product Identifier Label, 160-02371

The following label is located on the pizza box.

ITEM NO.	PART NUMBER	REV.	DESCRIPTION	QTY.
1	168-00065	1.0	Label Stock, Art Paper, White, 89mm x 51mm	1

REVISIONS			
REV.	DESCRIPTION	DATE	APPROVED
1.0	Initial release	Oct 18, 2022	AC



Notes:

1. Material: Art paper, White  
2. Font: Arial

Label info:

1. Part NO: Refer to the PO part number  
(Refer to the table as right)

2. USI P/N: Supplier part number

3. Quantity: According to the actual quantity

4. Rev X: X=The major revision of the ordering part number  
which can be found on the PO

5. Date Code: SSYYWW

SS: manufacturer number

YY: last two numbers of the year

WW: Week number of the year

D: Sun=1, Mon=2, Tue=3, Wed=4, Thu=5, Fri=6, Sat=7

6. Seal Date: According to the actual date

7. Reel ID: BXYYYYYYMMDDSSSS

B: Represent BOX LABEL

XXXX: Computer Code

YYYY: Year

MM: Month

DD: Date

SSSS: Serial number

8. Barcode Type: Code 128

9. Country of origin

10. CE logo, Size: height 5mm

11. UKCA logo, Size: 5x5mm

12. CE 5GHz pictogram

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS TOLERANCES ANGULAR: ± 5 AXIAL: ± 1.5	CAD FILE: 160-02371
INTERFERENT GEOMETRIC TOLERANCING PER ASME Y14.5M DATE Oct 18, 2022 SHEET 1 OF 1 SCALE: 2.5:1	SIZE DWG. NO. REV B 160-02371 1.0

Figure 30: Sona IF573 Bag and Box Product Identifier Label, 160-02371

The following package label is located on adjacent sides of the master carton.

ITEM NO.	PART NUMBER	REV.	DESCRIPTION	QTY.	REVISIONS
1	168-00066	1.0	Label Stock, Art Paper, White, 101mm x 64mm	1	REV. DESCRIPTION DATE APPROVED 1.0 Initial release Oct 18, 2022 AC

Notes:  
 1. Material: Art paper, White  
 2. Font: Arial

Label info:  
 1. Part NO: Refer to the PO part number (Refer to the table as right)  
 2. USI P/N: Supplier part number  
 3. Quantity: According to the actual quantity  
 4. Rev X: X=The major revision of the ordering part number which can be found on the PO  
 5. Date Code: SSYYWWWD  
 6. SS: manufacturer number  
 7. YY: last two numbers of the year  
 8. WW: Week number of the year  
 9. D: Sun=1,Mon=2,Tue=3,Wed=4,Thu=5,Fri=6,Sat=7  
 10. Seal Date: According to the actual date  
 11. Carton NO: CXXXXYYYYMMDDSSSS  
 12. C: Represent Carton LABEL  
 13. XXXX: Computer Code  
 14. YYYY: Year  
 15. MM: Month  
 16. DD: Date  
 17. SSSS: Serial number  
 18. Barcode Type: Code 128  
 19. 9. Country of origin  
 20. 10. CE logo, Size: height 5mm  
 21. 11. UKCA logo, Size: 5x5mm  
 22. 12. CE 5GHz pictogram  
 23. 13. Laird connectivity address

Type	Part NO
MIMO, MHF4	453-00117R
MIMO, Trace Pin	453-00118R

UNIT: mm  
 UNLESS OTHERWISE SPECIFIED  
 DIMENSIONS ARE IN MILLIMETERS  
 TOLERANCES  
 X-X: ± 1.5  
 Z-Z: ± 1.5  
 INTERFERENT GEOMETRIC  
 TOLERANCING PER: ASME 14.5M  
 CAD FILE: 160-02372  
 TITLE: Label, Carton Product Identifier, Sona IF573, 101mm x 64mm  
 DATE: Oct 18, 2022  
 SIZE DWG. NO. B 160-02372 REV. 1.0  
 SHEET 1 OF 1 SCALE: 2:1

Figure 31: Sona IF573 Carton Product Identifier Label, 160-0273